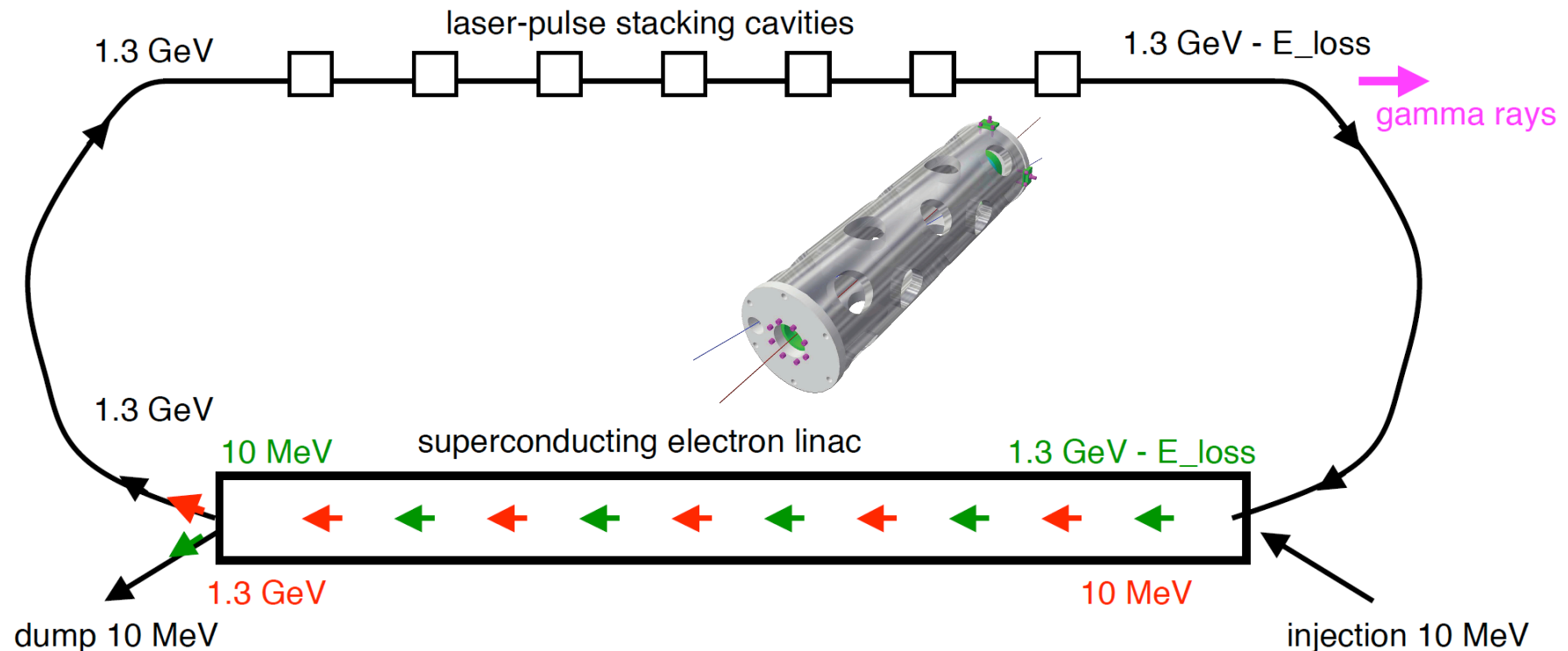


ERL based Compton e^+ source for ILC



Tsunehiko OMORI (KEK)

ILCWS 2007@DESY

31/May/2007

World-Wide Compton Collaboration

Collaborating Institutes:

BINP, CERN, DESY, Hiroshima, IHEP, IPN, KEK,
Kyoto, LAL, NIRS, NSC-KIPT, SHI, Waseda,
BNL, JAEA, and ANL

**Sakae Araki, Yasuo Higashi, Yousuke Honda, Masao Kuriki, Toshiyuki Okugi, Tsunehiko Omori,
Takashi Taniguchi, Nobuhiro Terunuma, Junji Urakawa, X. Artru, M. Chevallier, V. Strakhovenko,
Eugene Bulyak, Peter Gladkikh, Klaus Meonig, Robert Chehab, Alessandro Variola, Fabian Zomer,
Alessandro Vivoli, Richard Cizeron, V. Soskov, M. Jacquet, R. Chiche, Y. Fedala, D. Jehanno, C. Sylvia,
Frank Zimmermann, Kazuyuki Sakaue, Tachishige Hirose,
Masakazu Washio, Noboru Sasao, Hirokazu Yokoyama, Masafumi Fukuda, Koichiro Hirano,
Mikio Takano, Tohru Takahashi, Hirotaka Shimizu, Shuhei Miyoshi, Akira Tsunemi, Ryoichi Hajima,
Li Xiaoping, Pei Guoxi, Jie Gao, V. Yakinenko, Igo Pogorelsky, Wai Gai, and Wanming Liu**

3 of Compton schemes

1. Ring-based Compton.

2. ERL-based Compton.

3. linac-based Compton.

3 of Compton schemes

similar : re-use

1. Ring-based Compton.

2. ERL-based Compton.

3. liniac-based Compton.

throw-away e- beam

3 of Compton schemes

similar : re-use

1. Ring-based Compton.

different

2. ERL-based Compton.

3. linac-based Compton.

throw-away e- beam

3 of Compton schemes

1. Ring-based Compton.

2. ERL-based Compton.

new comer: no parameter-set yet

3. linac-based Compton.

Today's Talk

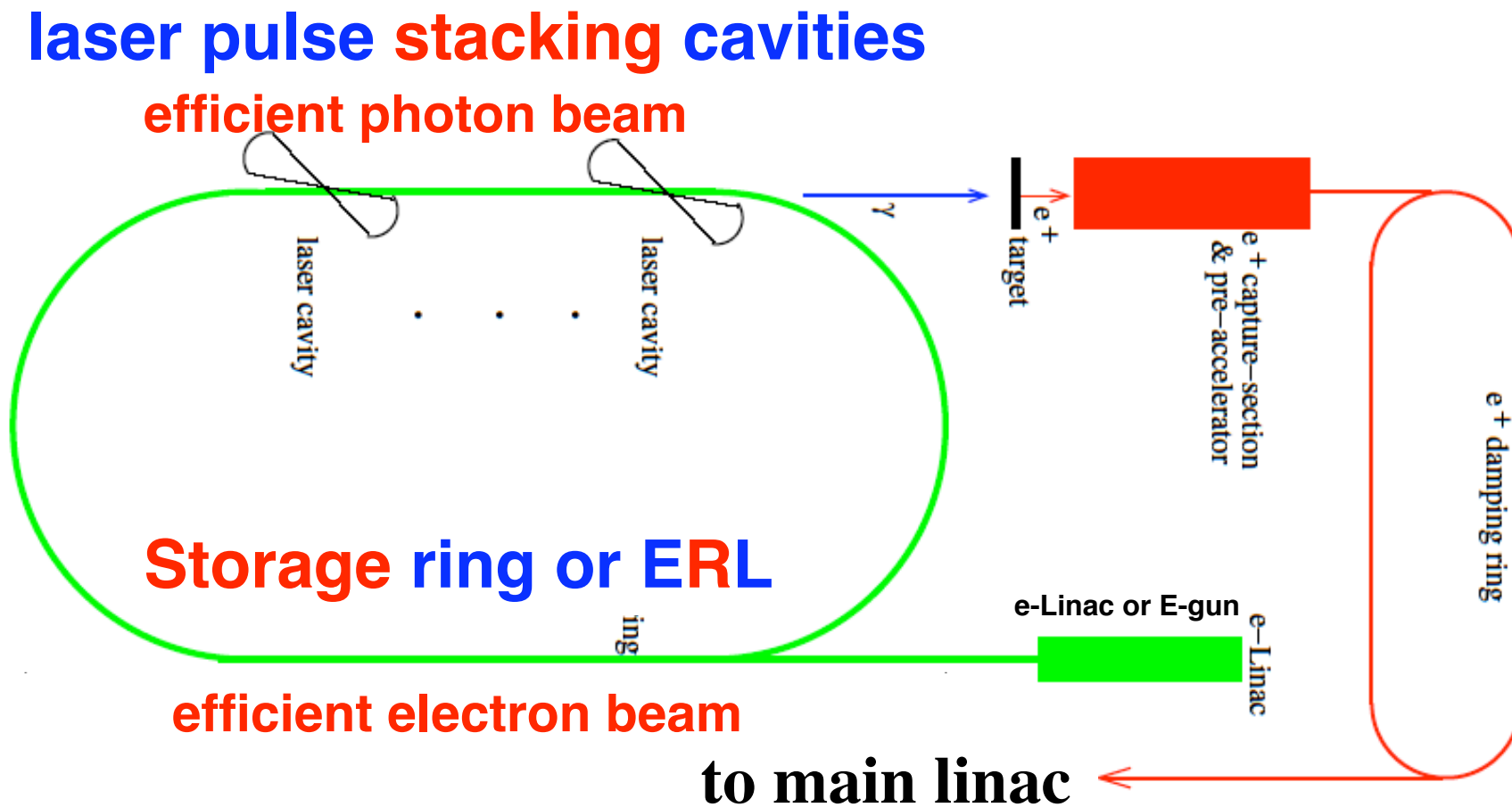
**Aim : to get working-assumption-
models of ERL scheme**

**I will consider many constraints
and show two models.**

Ring/ERL Compton

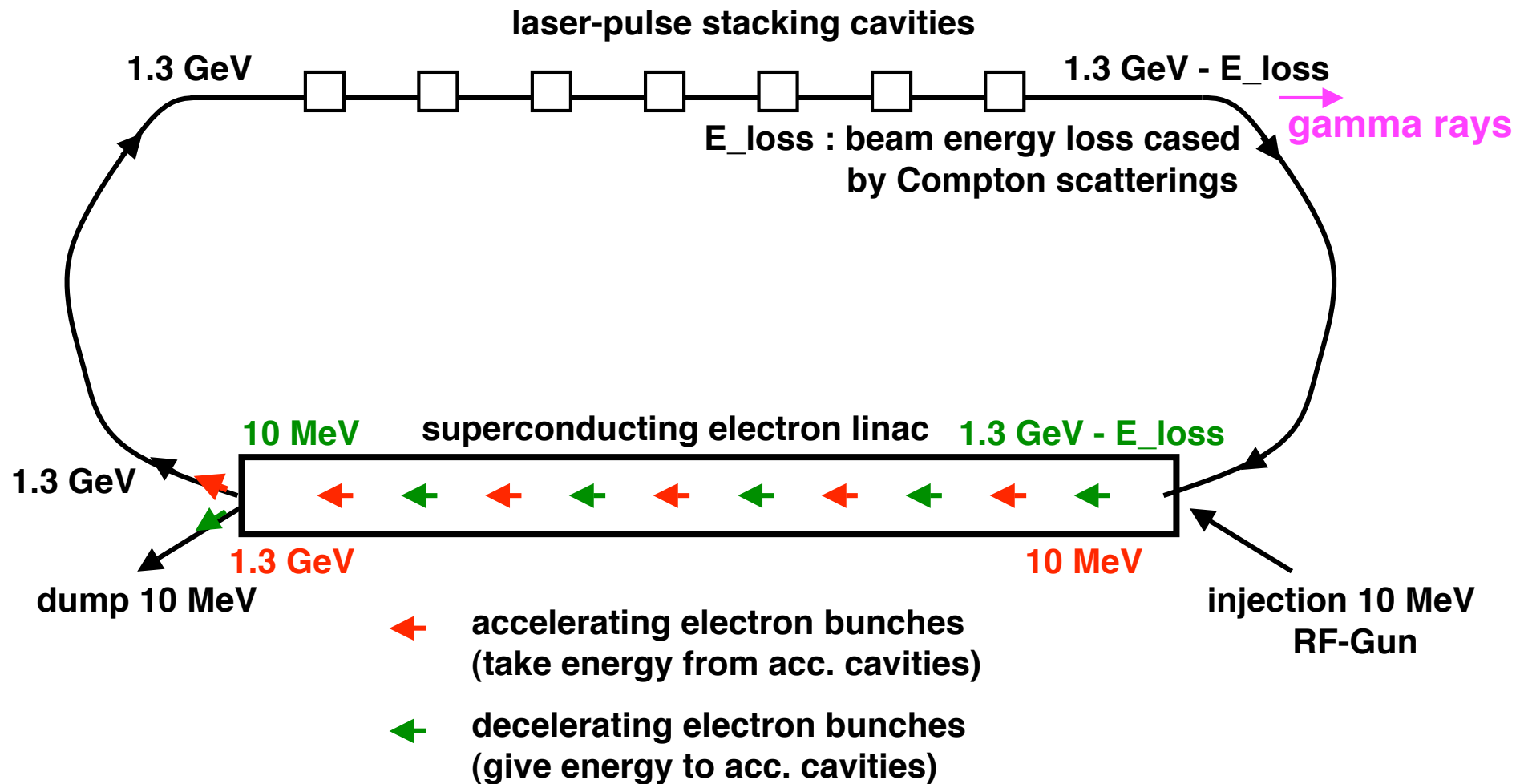
Re-use Concept

positron stacking in main DR



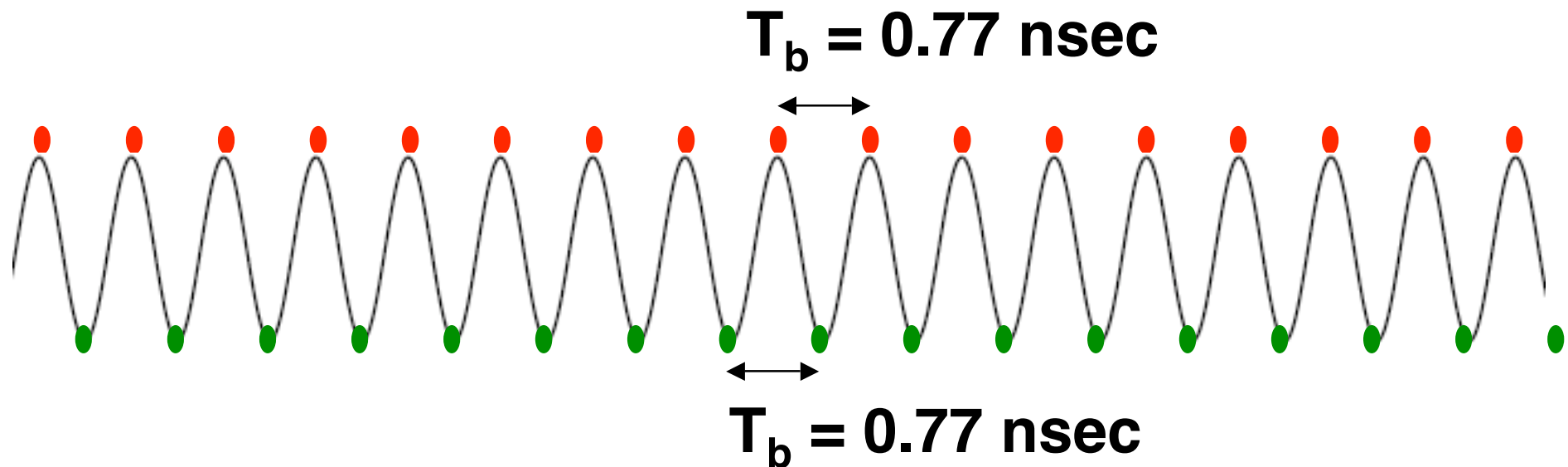
What is ERL?

What is ERL based Compton source?



What is ERL?

e^- bunches in ERL ($f_{RF} = 1.3$ GHz)



- Accelerating bunches
- Decelerating bunches

T_b : bunch to bunch separation

Points of ERL 1

Re use: Energy of electron beam.

Throw away: electron beam.

Points of ERL 1

Re use: Energy of electron beam

Throw away: electron beam.

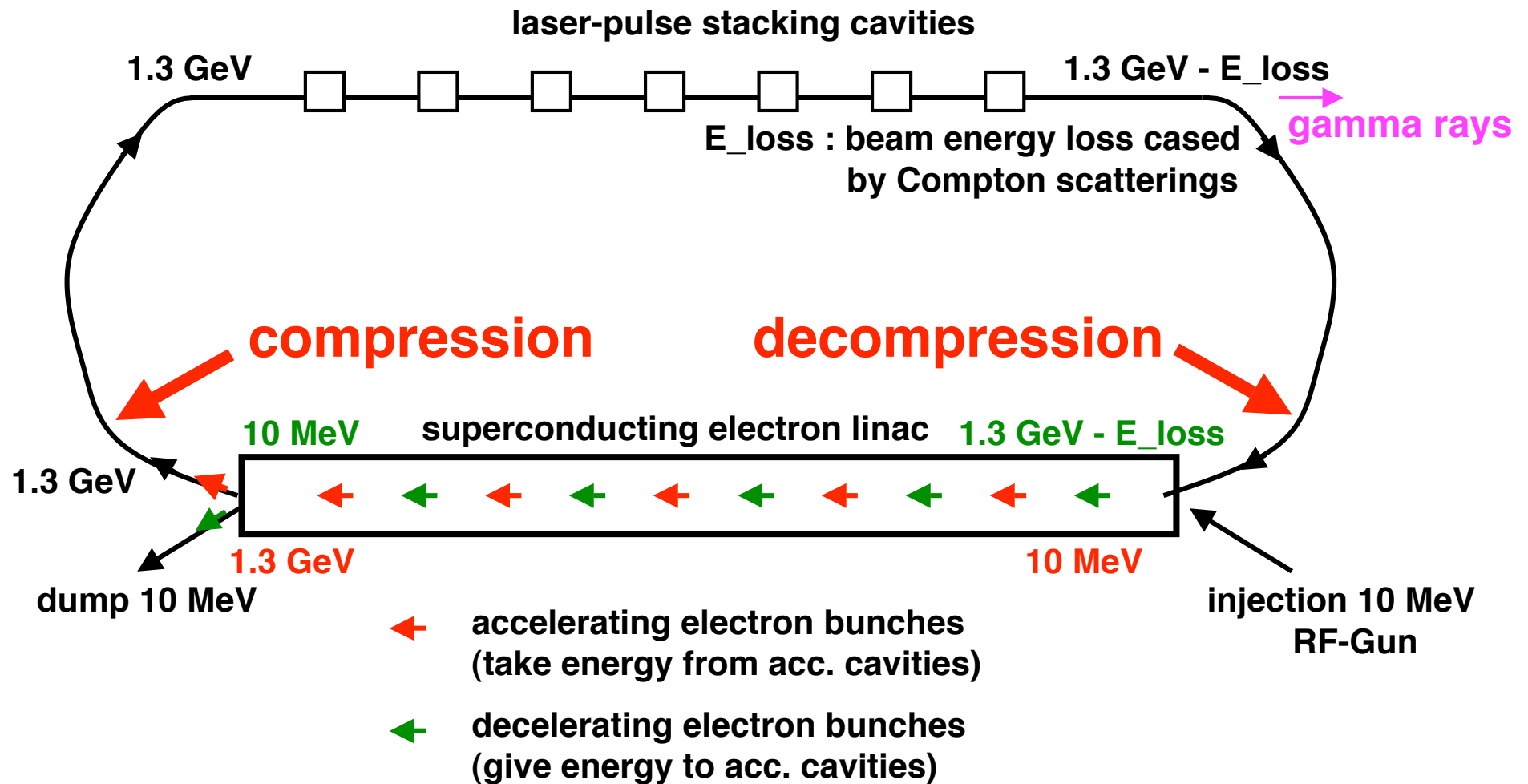
Points of ERL 2

Fresh, high quality beam.

Easy beam compression.

What is ERL?

What is ERL based Compton source?



Points of ERL 1

Re use: Energy of electron beam

Throw away: electron beam.

Points of ERL 2

Fresh, high quality beam

Easy beam compression

Points of ERL 3

Need steady exchange of energy:

Acc-Bunches, Decl-Bunches, Klystrons

Need CW operation

Points of ERL 1

Re use: Energy of electron beam

Throw away: electron beam.

Points of ERL 2

Fresh, high quality beam

Easy beam compression

Points of ERL 3

Need steady exchange of energy:

Acc-Bunches, Decl-Bunches, Klystrons

Need CW operation

Injection : ERL --> DR

Constraint 1 : ERL needs CW operation

choice: quasi-CW operation

1) first 100 msec

ERL operation + top-up injection to DR

very different from storage ring scheme

2) 2nd 100 msec

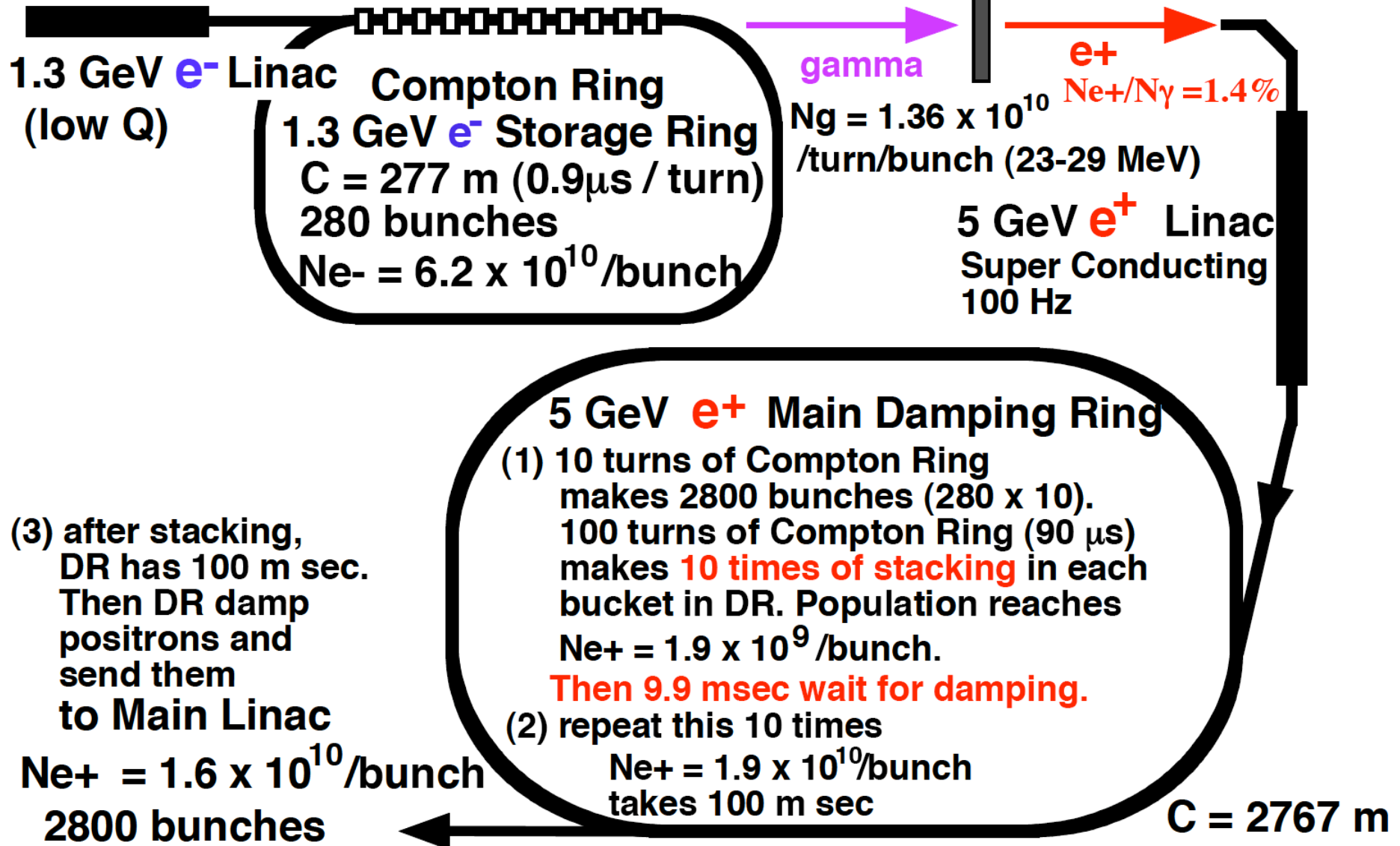
damping in DR

Snowmass 2005 Ring based Compton

30 YAG Laser Pulse Stacking Cavities

600 mJ in each cavity, 8 degree crossing to e- beam
(collisions in 100 turns + 9.9 msec cooling)x100 Hz

Ne+ = 1.9×10^8 /bunch
280 bunches



Snowmass 2005 Ring based Compton

Burst injection

1) first 100 m sec

10 x (injection 0.1 ms + **damping 9.9 ms**)
required by both DR and Compton ring

--->

total : **injection 1 ms** + damping 99 ms

2) second 100 m sec

damping in DR

Snowmass 2005 Ring based Compton

Burst injection

1) first 100 m sec

10 x (injection 0.1 ms + **damping 9.9 ms**)
required by both DR and Compton ring

--->

total : **injection 1 ms** + damping 99 ms

2) second 100 m sec

damping in DR

ERL scheme --> top-up injection

injection 100 ms

top-up injection

possible? working assumption

Snowmass 2005 Ring based Compton

Burst injection

1) first 100 m sec

10 x (injection 0.1 ms + **damping 9.9 ms**)
required by both DR and Compton ring

--->

total : **injection 1 ms** + damping 99 ms

2) second 100 m sec
damping in DR

ERL scheme --> top-up injection

injection 100 ms

top-up injection

possible? **working assumption**

**x 100
gain**



ERL scheme has "x100 gain" in time

Tight e^+ selection in the Capture system

Get better emittance of e^+ in Capture

typical capture: $N_{e^+ \text{ (Captured)}} / N_\gamma \sim 2 \%$



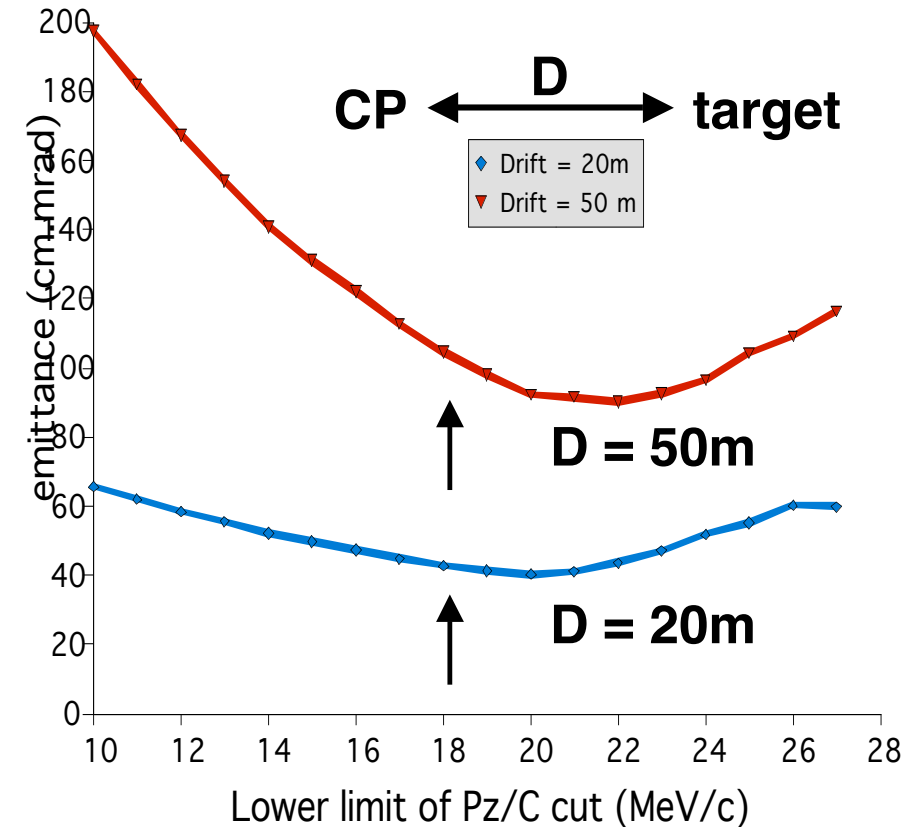
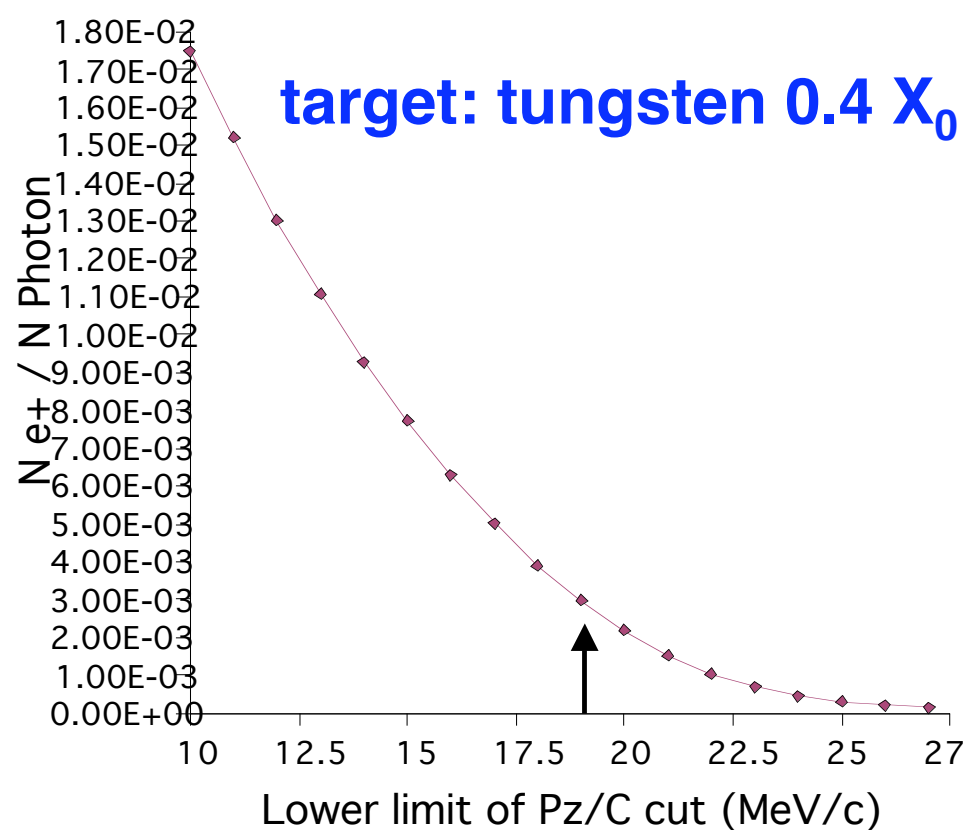
**intentional reduction
to get better ε**

Proposal: $N_{e^+ \text{ (Captured)}} / N_\gamma \sim 0.3 \%$

How to reduce N_{e^+} ?

- (1) Pz selection**
- (2) reduce target thickness**
- (3) combination of (1) and (2)**

Preliminary study by Wanming & Wei (ANL)



if $P_z > 18 \text{ MeV/c} \rightarrow Ne^+/N_\gamma \sim 0.3\% \quad Pol \sim 80\%$
 $\epsilon(\text{geo})$ at target exit $\sim 100 \text{ cm-mrad (D=50m)}$
 $\sim 50 \text{ cm-mrad (D=20m)}$

Injection : ERL --> DR

Constraint 1 : ERL needs CW operation

choice: quasi-CW operation

1) first 100 msec

ERL operation + top-up injection to DR

very different from storage ring scheme

2) 2nd 100 msec

damping in DR

Constraint 2 : $T_{b_ERL} = nT_{b_DR}$

Injection : ERL --> DR

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ERL operation + top-up injection to DR

very different from storage ring scheme

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damping in DR

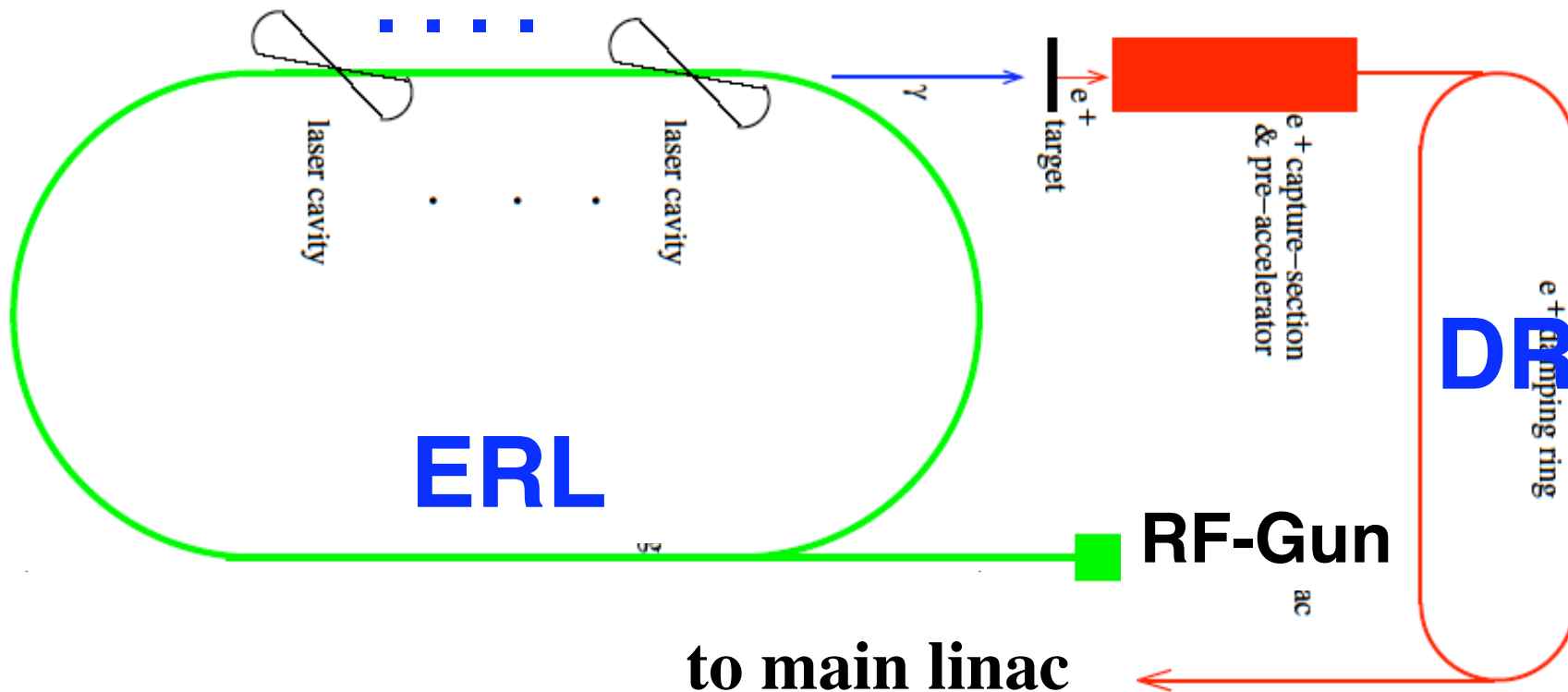
Constraint 2 : $T_{b_ERL} = nT_{b_DR}$

Constraint : T_b in ERL \leftrightarrow T_b in DR

$$T_{b_ERL} = n T_{b_DR} \quad (n=1, 2, 3, \dots)$$

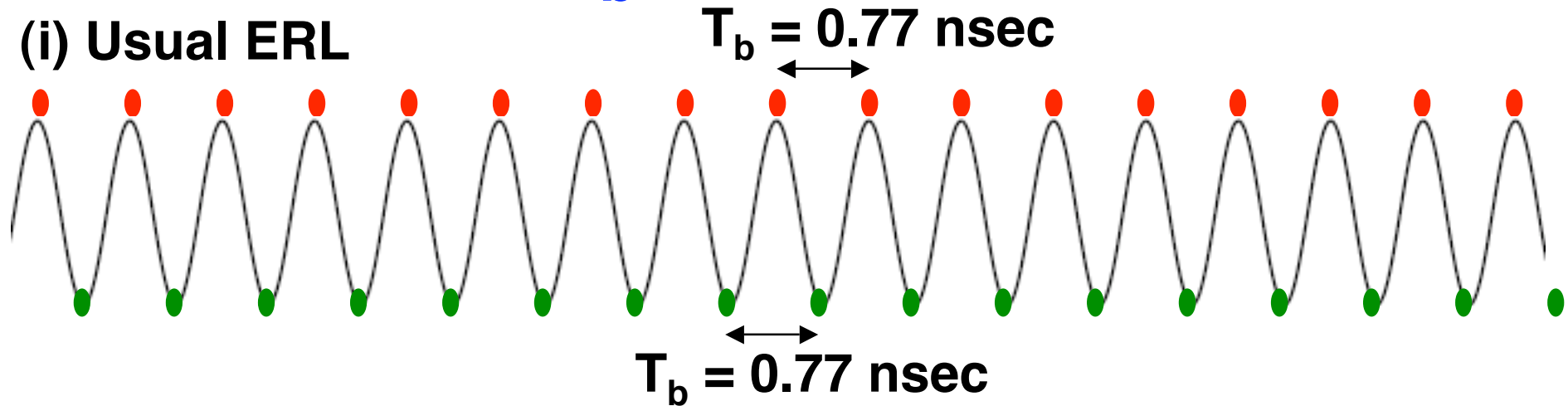
$T_{b_ERL} =$ 6.15 nsec
12.3 nsec
18.5 nsec
.....

$T_{b_DR} = 6.15$ nsec

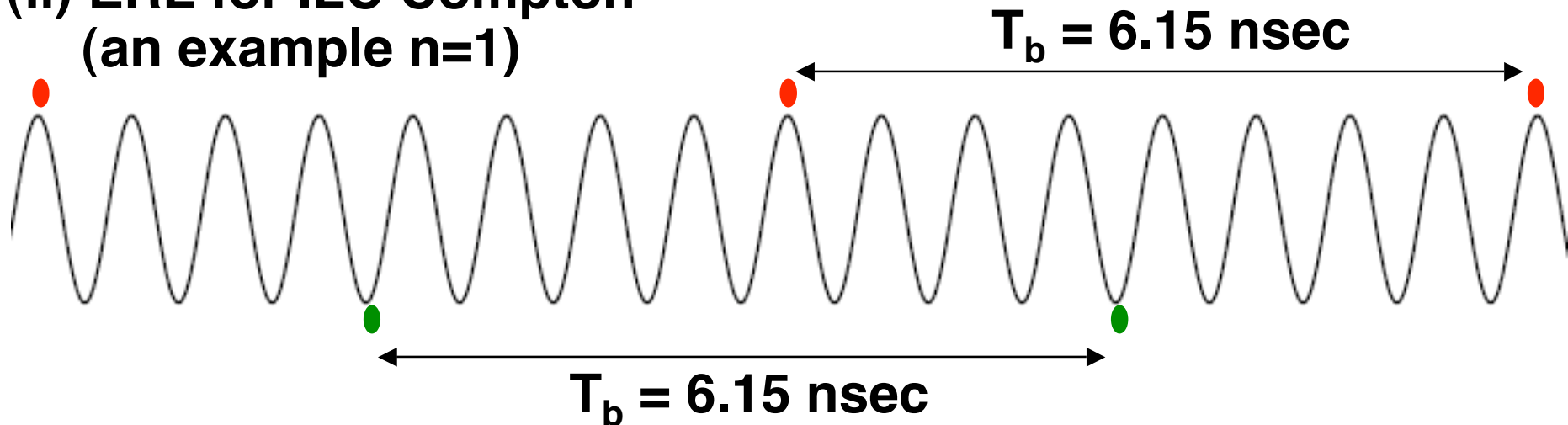


Constraint : T_b in ERL

(i) Usual ERL



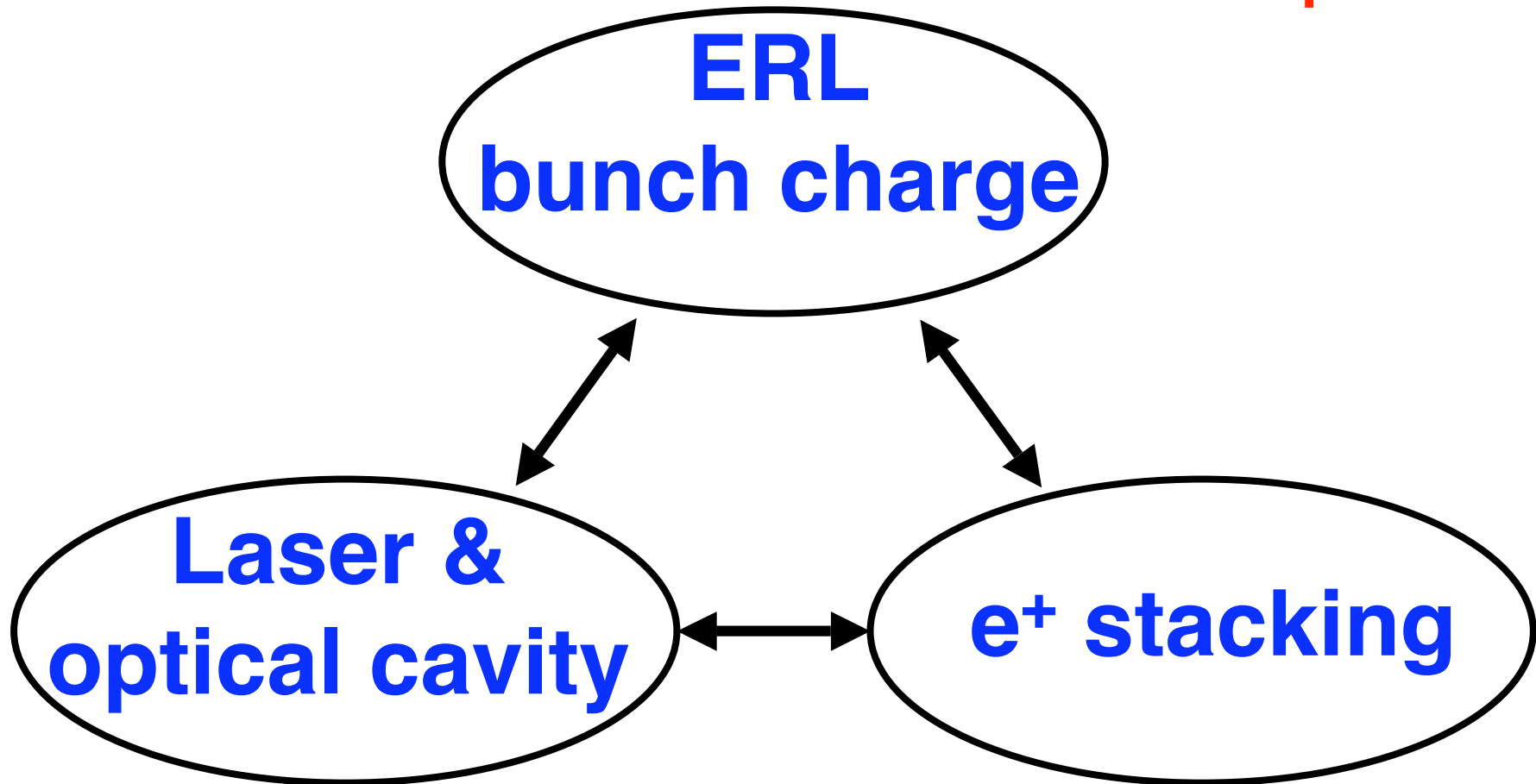
(ii) ERL for ILC Compton
(an example $n=1$)



- Accelerating bunches
- Decelerating bunches

Selection of bunch repetition: f_{rep}

3 factors to determine f_{rep}



Compare two choices

(a) $f_{\text{rep}} = 163 \text{ MHz}$

$$T_{\text{b_ERL}} = T_{\text{b_DR}} = 6.15 \text{ nsec}$$

(b) $f_{\text{rep}} = 40.8 \text{ MHz}$

$$T_{\text{b_ERL}} = 4T_{\text{b_DR}} = 24.6 \text{ nsec}$$

Common parameters

ERL: $f_{\text{RF}} = 1.3 \text{ GHz}$ ($T_{\text{bucket-to-bucket}} = 0.77 \text{ ns}$)

$E_{\text{e-beam}} = 1.3 \text{ GeV}$

$\sigma_z = 0.7 \text{ ps at CP}$

$\sigma_z = 2 - 3 \text{ ps in Liniac}$

DR: $T_{\text{b_DR}} = 6.15 \text{ ns}$

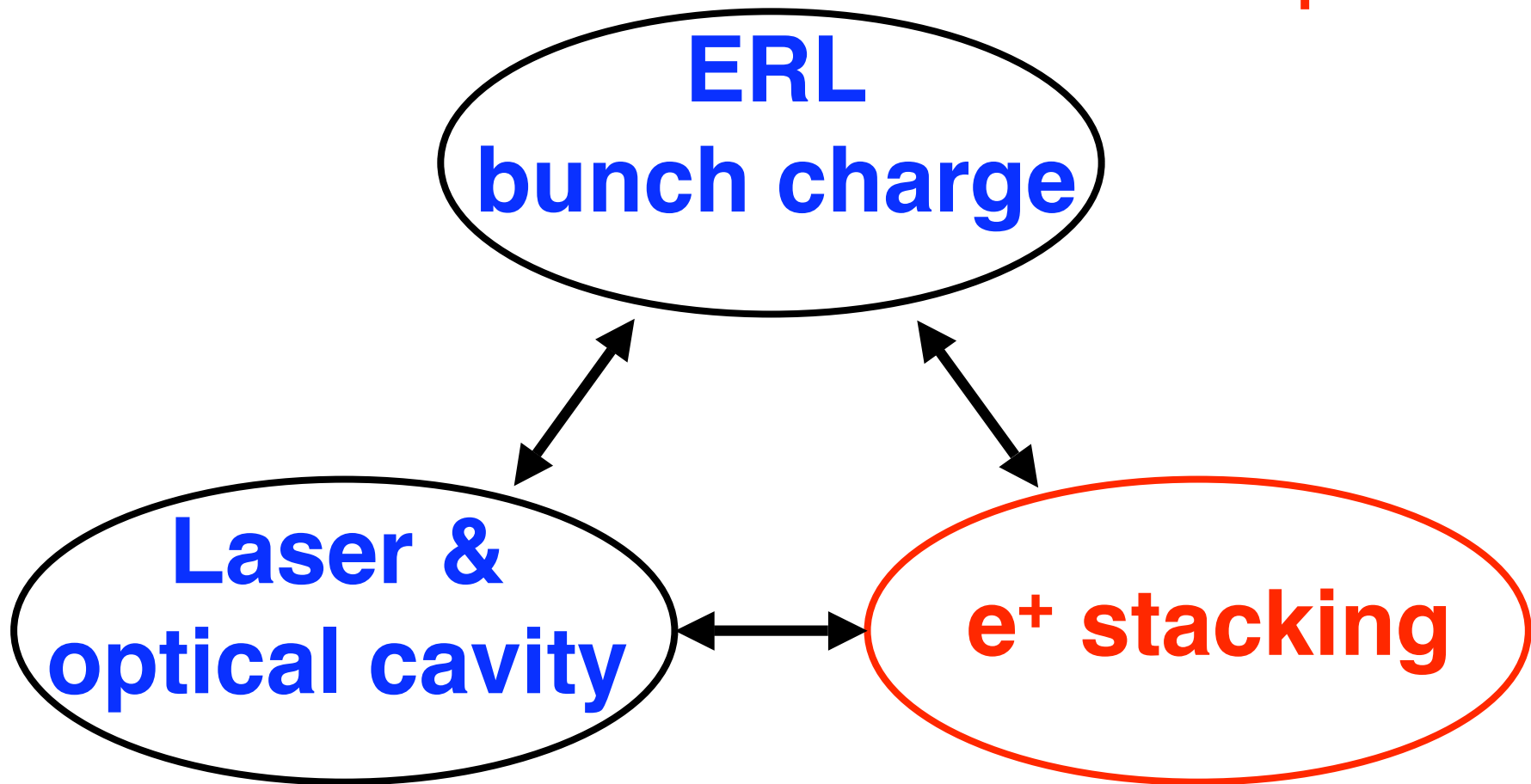
Laser: $\lambda_{\text{Laser}} = 1064 \text{ nm}$

$\sigma_z = 0.8 \text{ ps at CP (after compression)}$

$\sigma_z = \sim 500 \text{ psec in Amp.}$

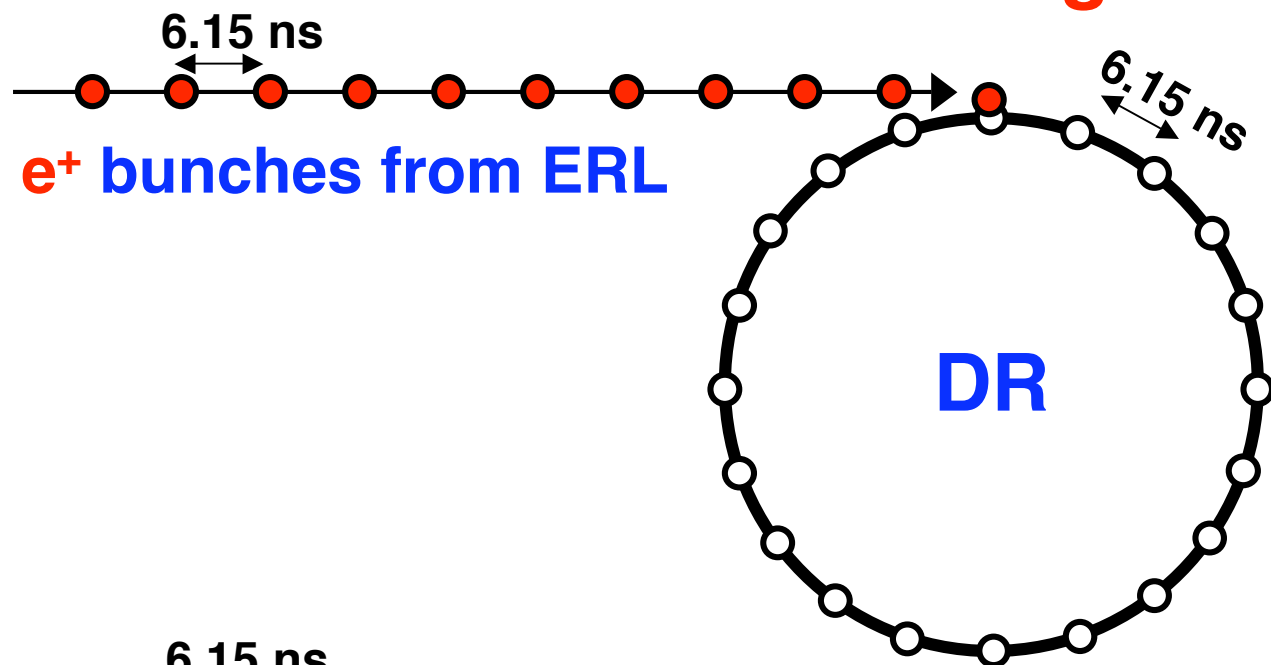
Selection of bunch repetition: f_{rep}

3 factors to determine f_{rep}

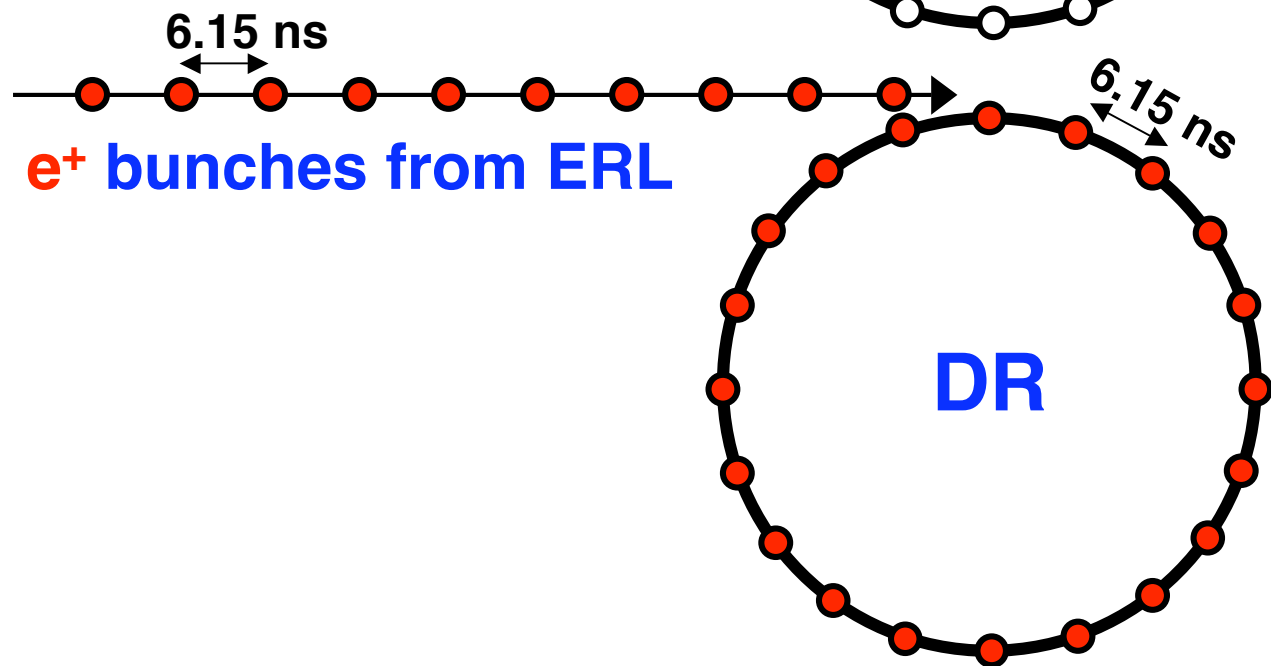


(a) $f_{\text{rep}} = 163 \text{ MHz}$: 1st turn of DR stacking

**(1) 1st turn
begin**

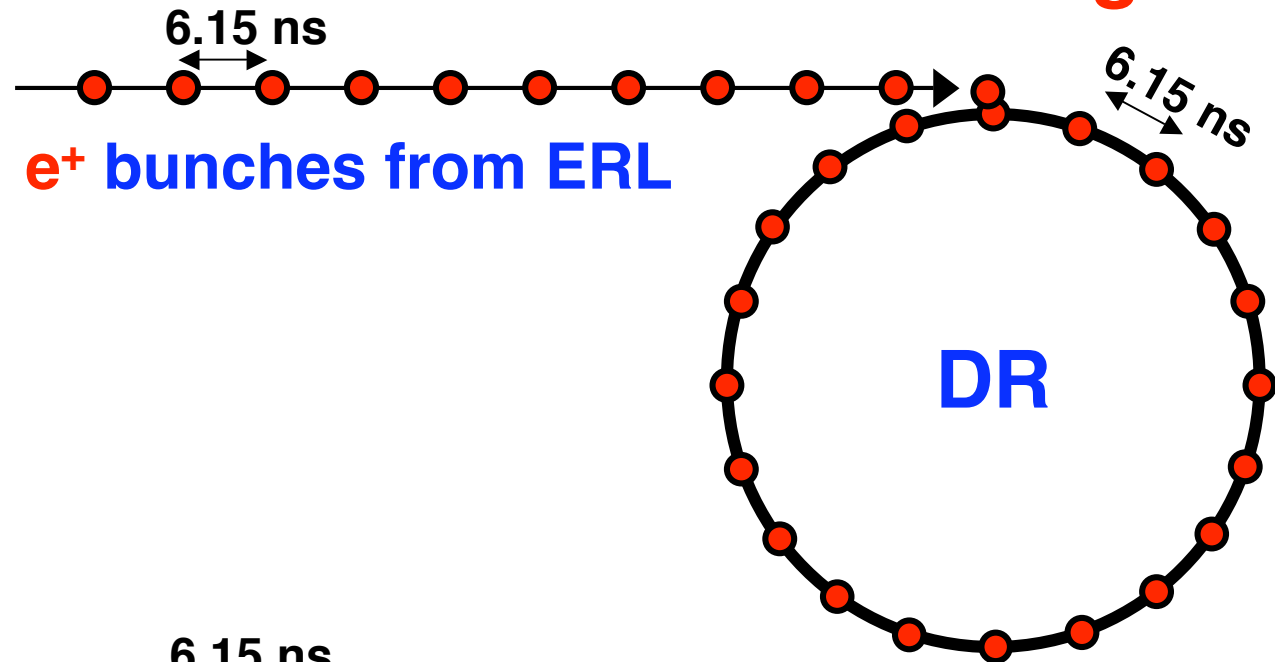


**(2) 1st turn
end**

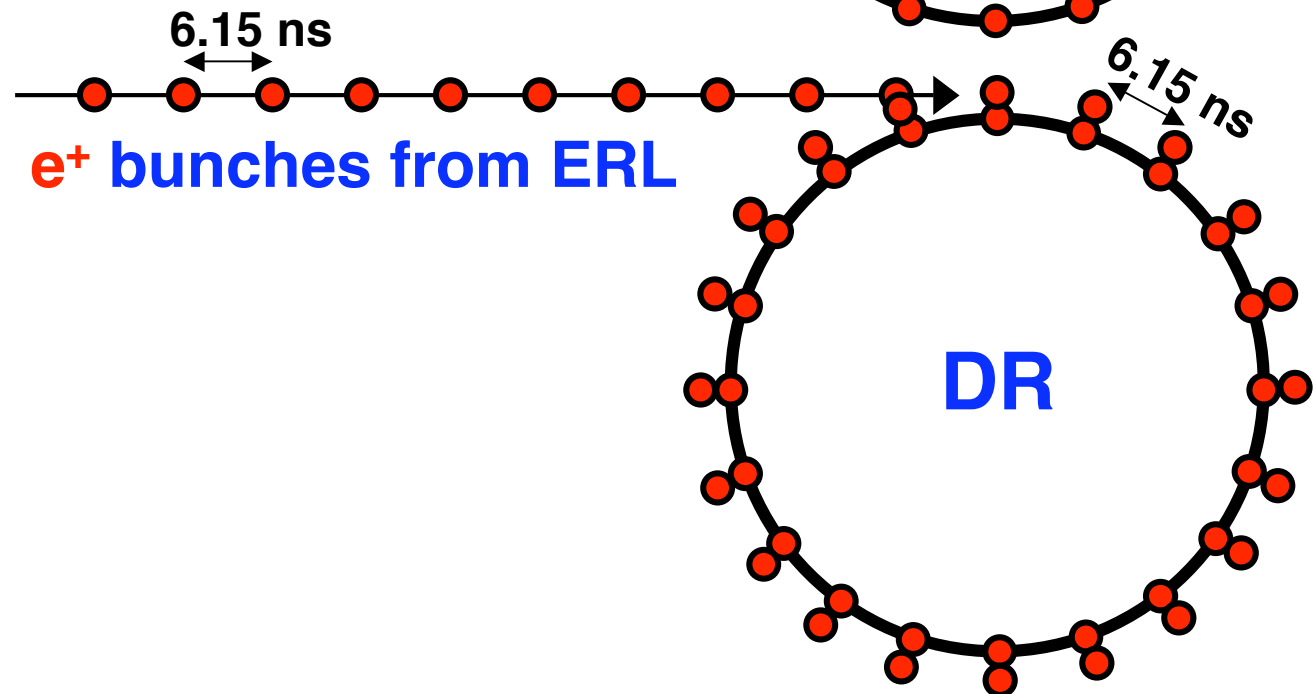


(a) $f_{\text{rep}} = 163 \text{ MHz}$: 2nd turn of DR stacking

(3) 2nd turn
begin

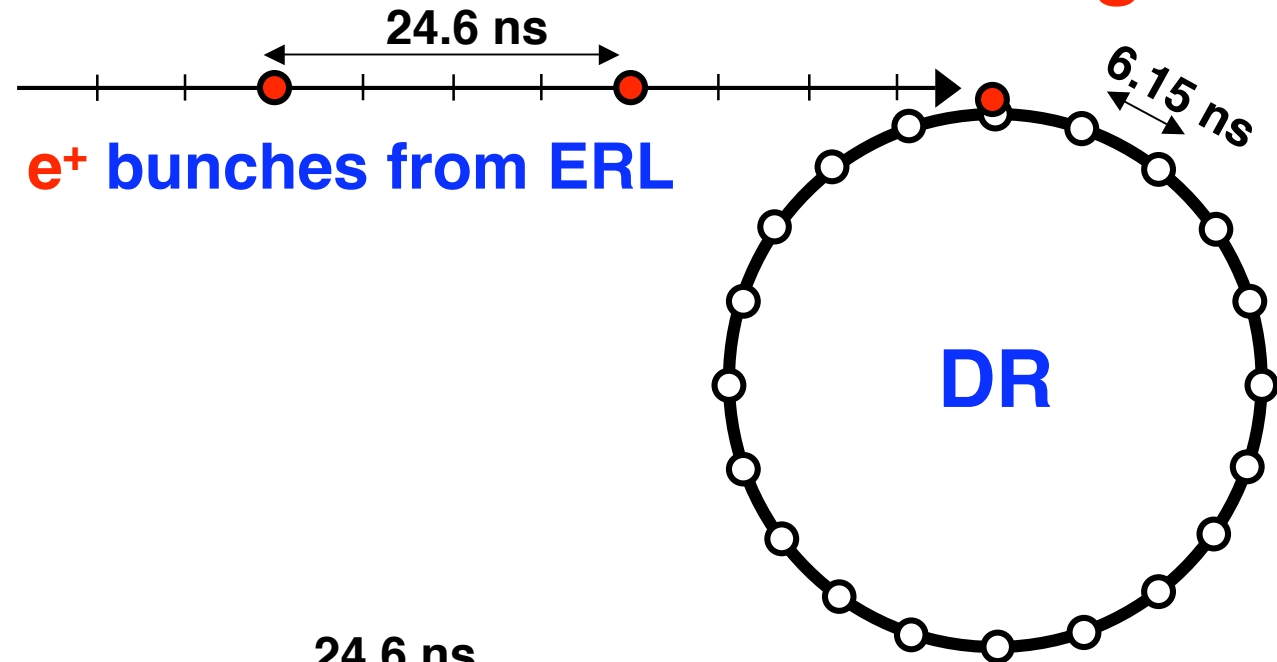


(4) 2nd turn
end

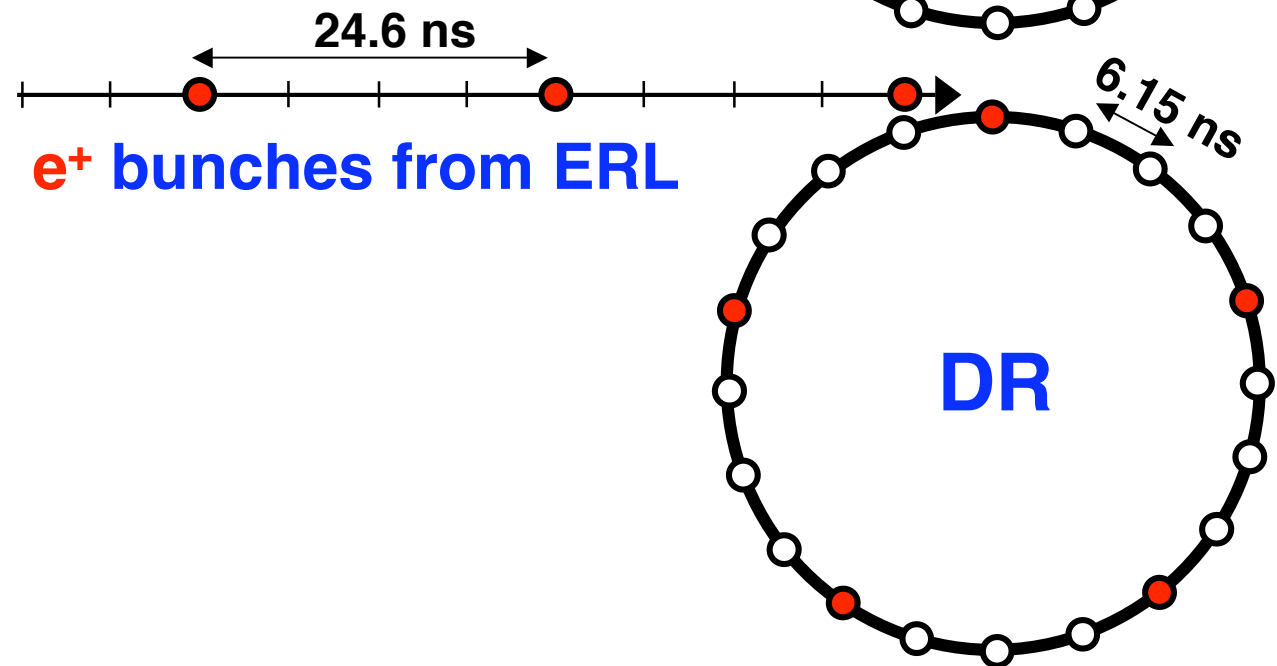


(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 1st turn of DR stacking

**(1) 1st turn
begin**

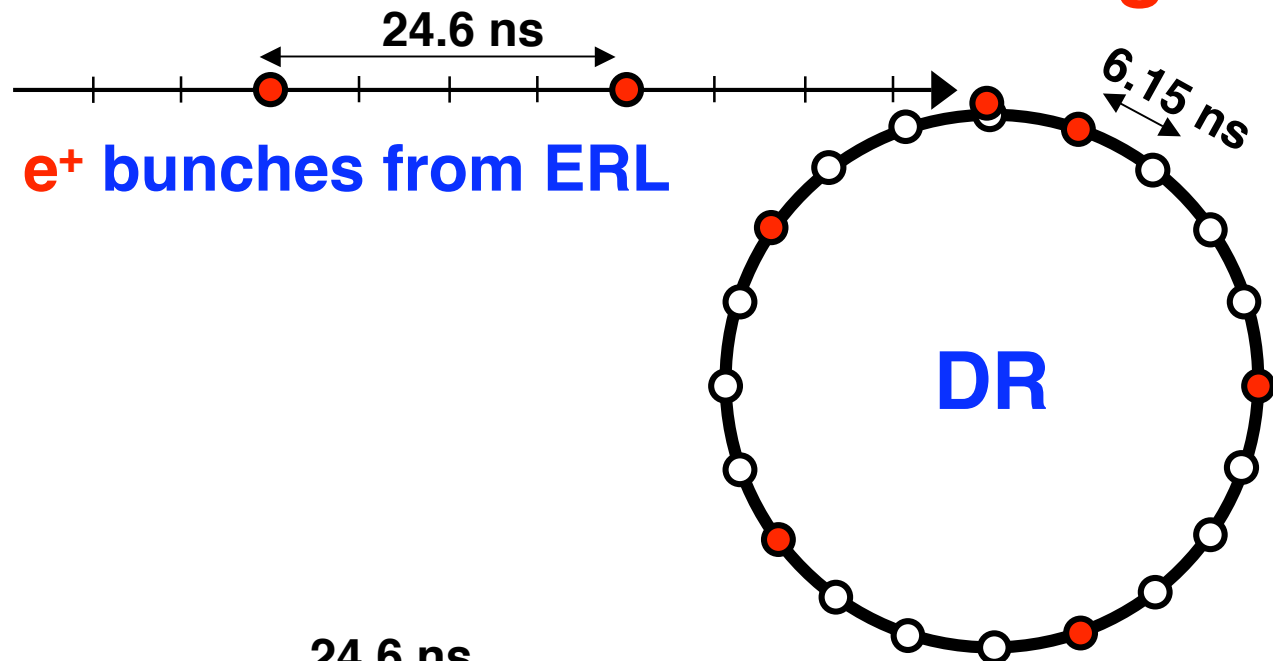


**(2) 1st turn
end**

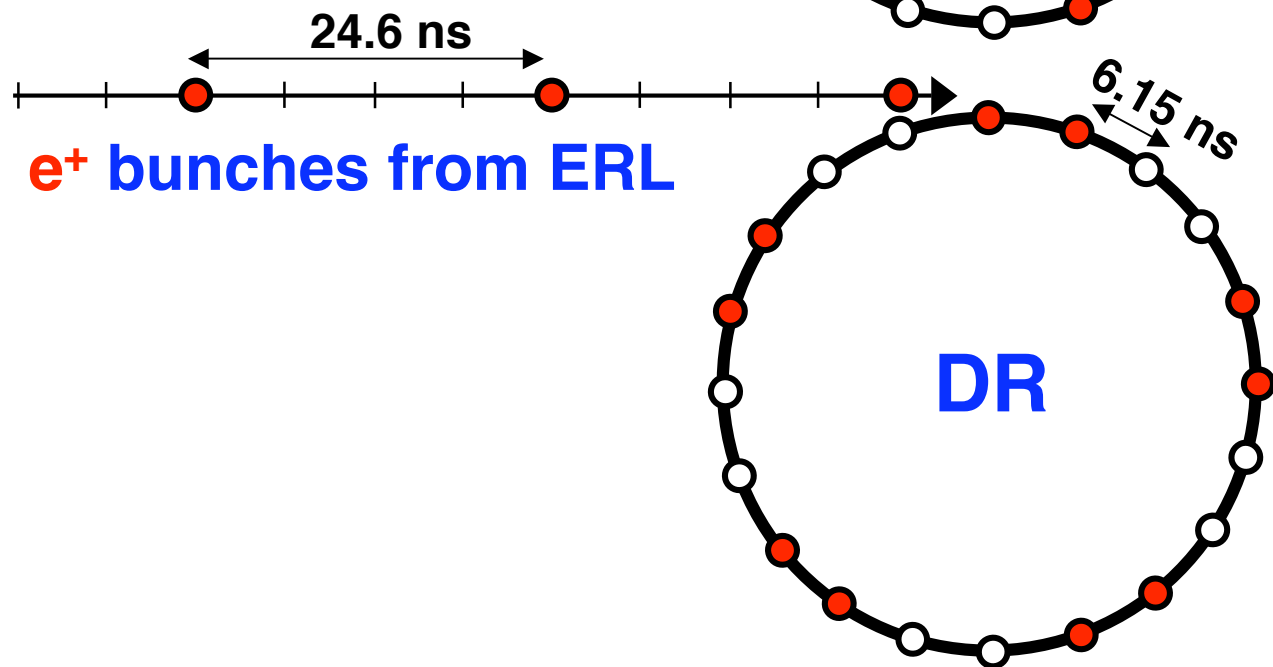


(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 2nd turn of DR stacking

**(1) 2nd turn
begin**

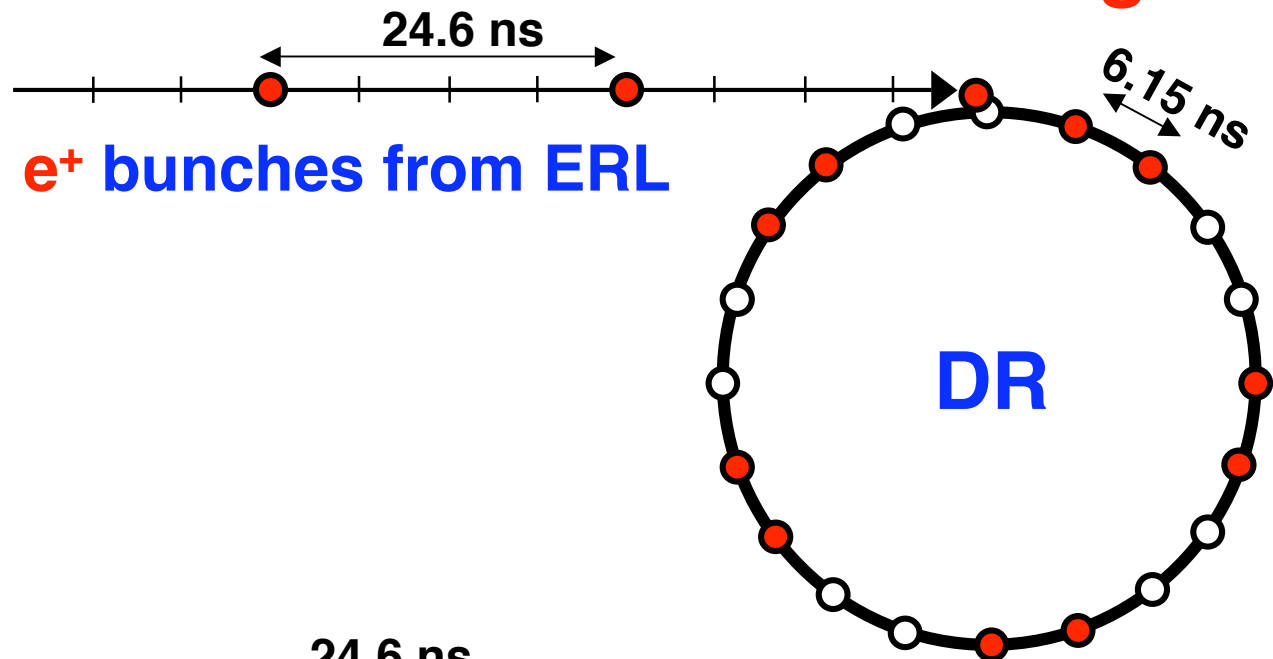


**(2) 2nd turn
end**

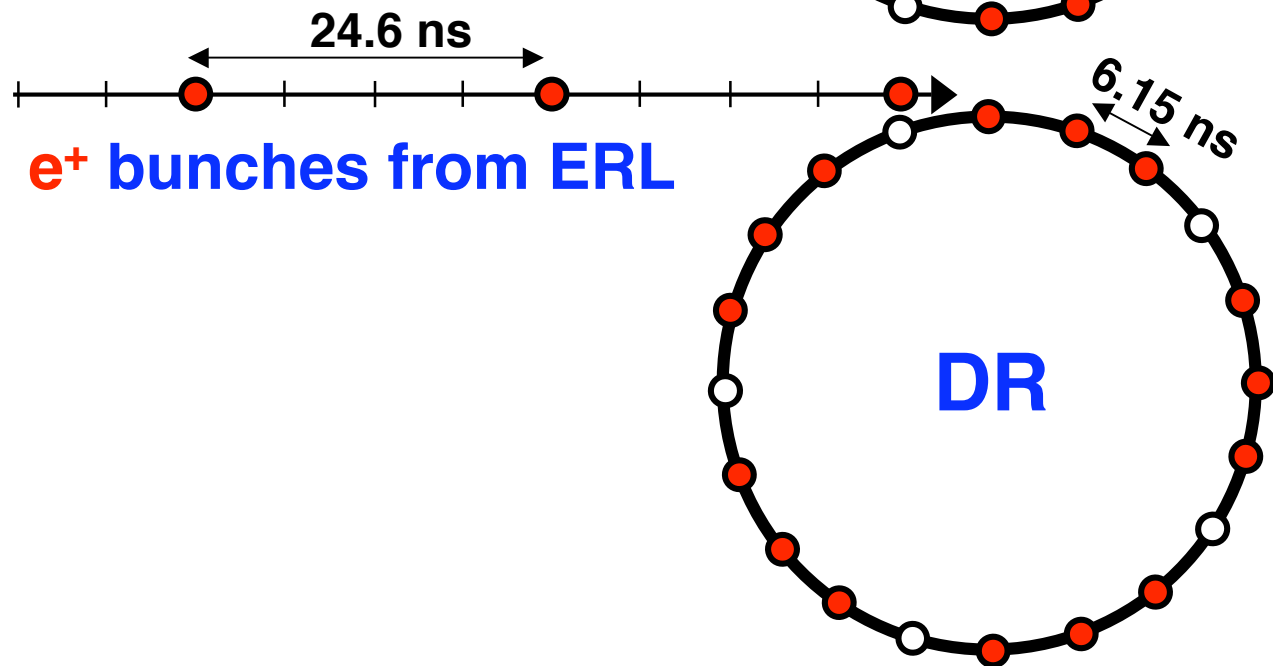


(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 3rd turn of DR stacking

**(1) 3rd turn
begin**

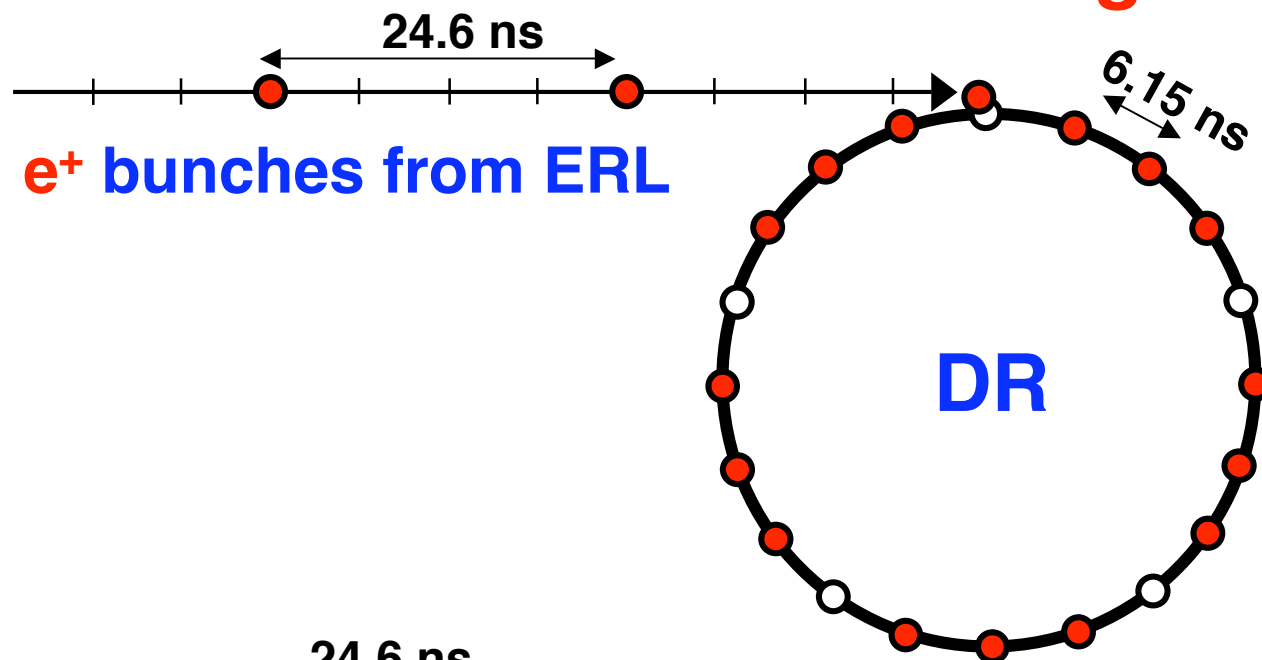


**(2) 3rd turn
end**

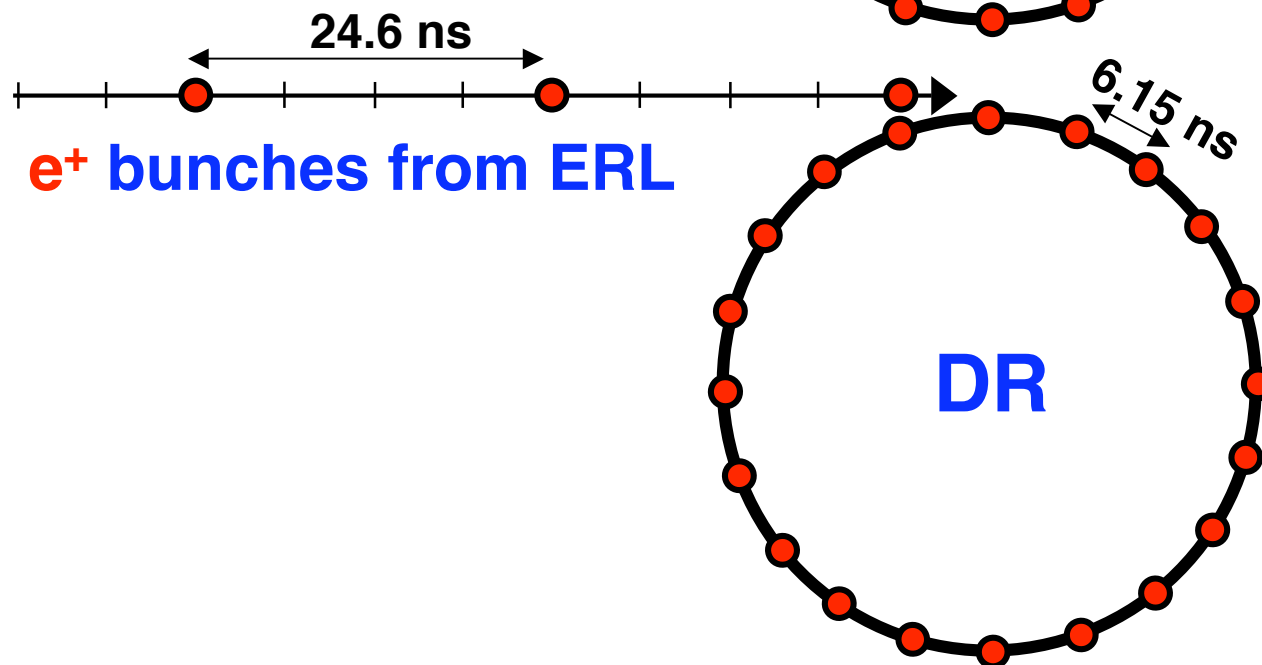


(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 4th turn of DR stacking

**(1) 4th turn
begin**

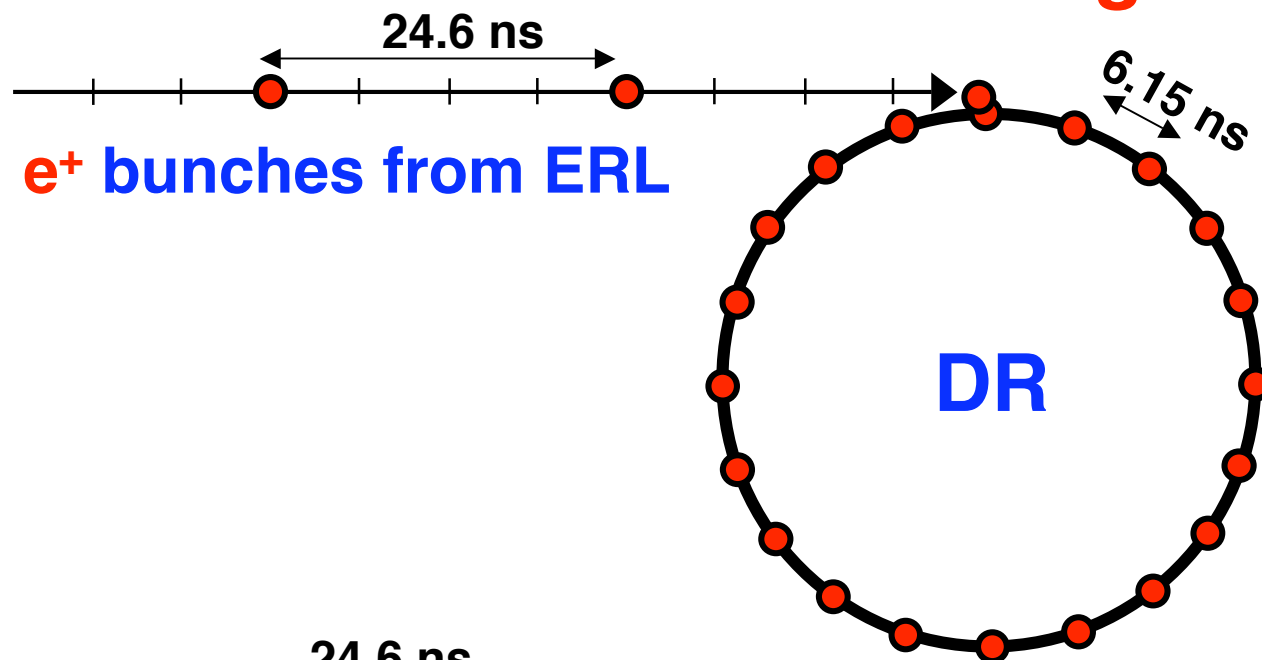


**(2) 4th turn
end**

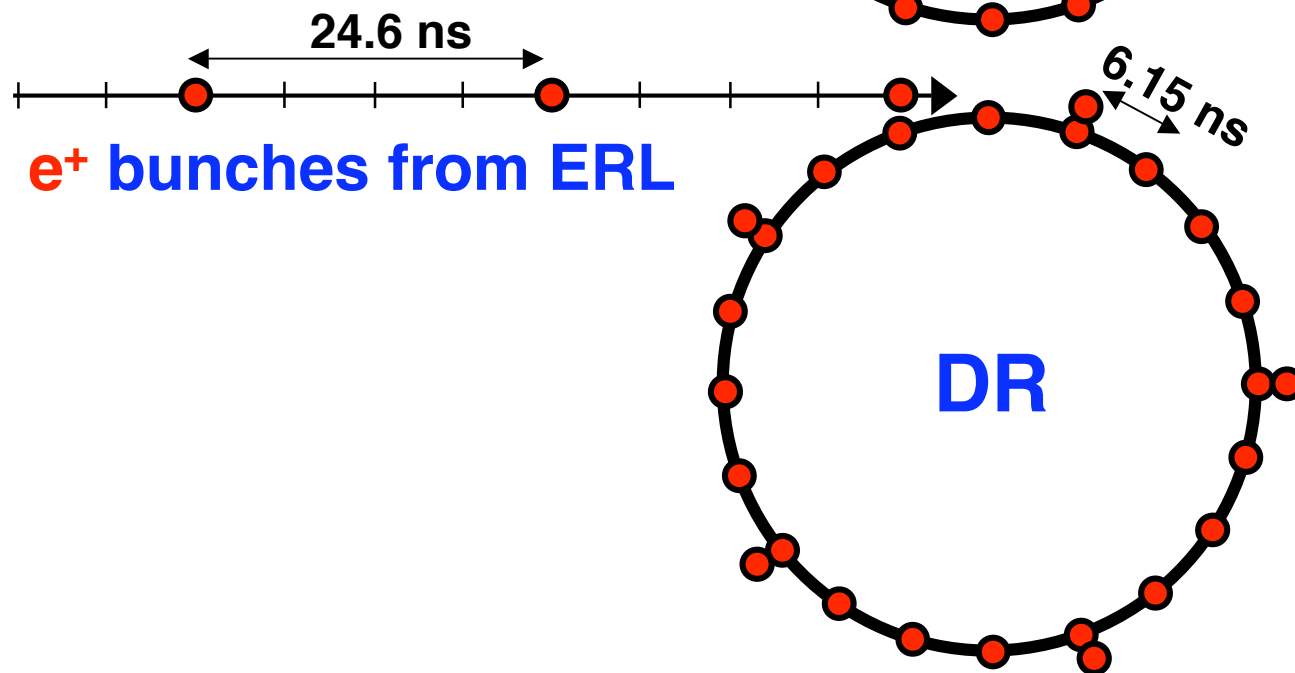


(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 5th turn of DR stacking

**(1) 5th turn
begin**



**(2) 5th turn
end**



(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 6th-7th turn of DR stacking

stacking goes on.

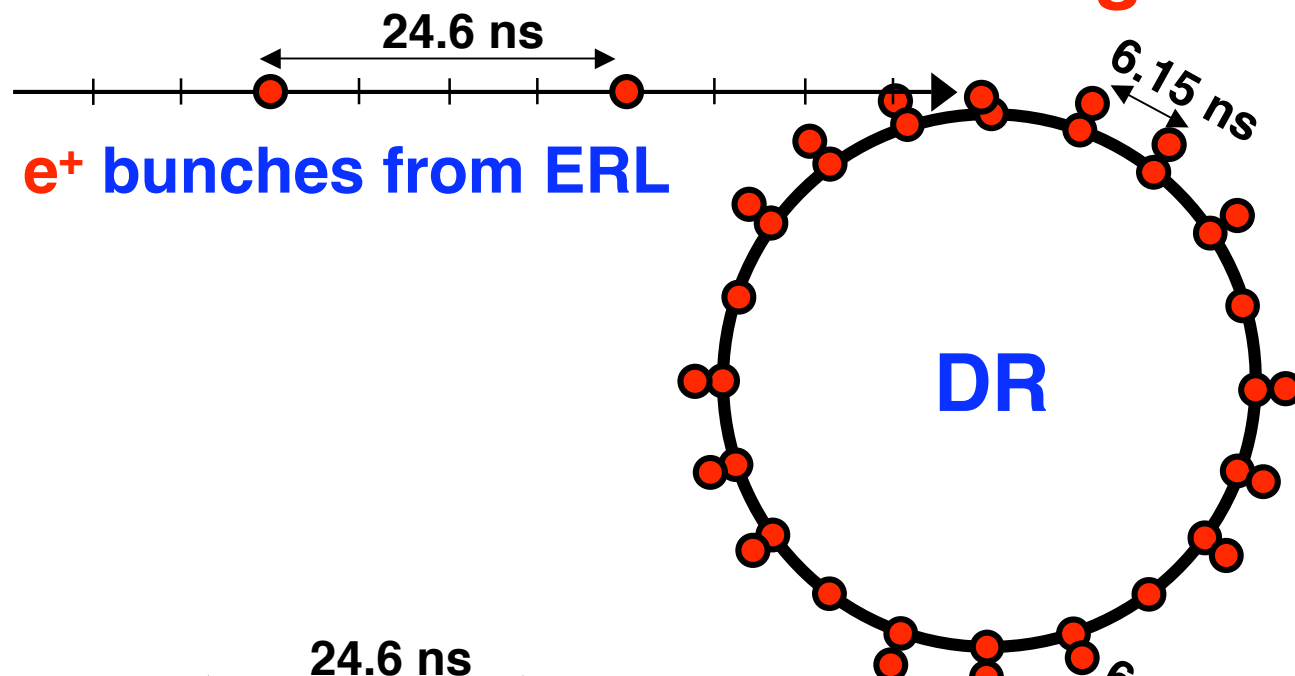
6 th turn of DR stacking

7 th turn of DR stacking

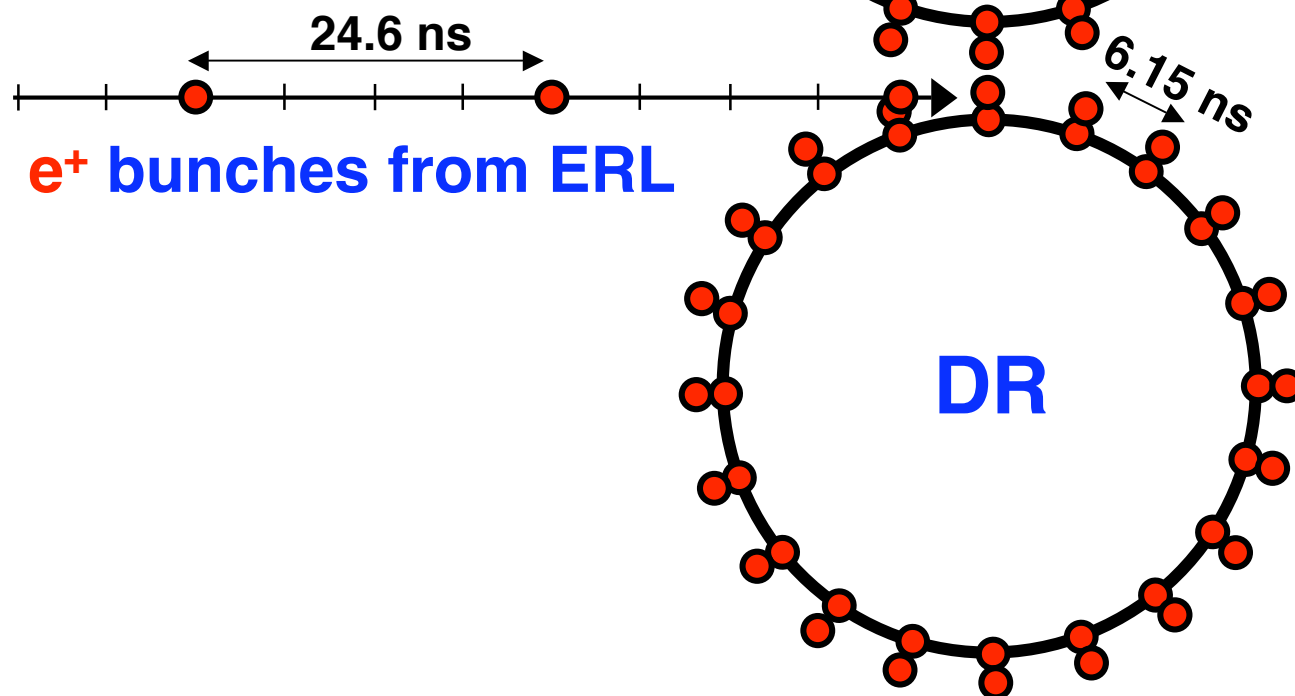
then,

(b) $f_{\text{rep}} = 40.8 \text{ MHz}$: 8th turn of DR stacking

**(1) 8th turn
begin**



**(2) 8th turn
end**



From View point of e⁺ stacking

(a) $f_{\text{rep}} = 163 \text{ MHz}$

$$T_{\text{b_ERL}} = T_{\text{b_DR}} = 6.15 \text{ nsec}$$

(b) $f_{\text{rep}} = 40.8 \text{ MHz}$

$$T_{\text{b_ERL}} = 4T_{\text{b_DR}} = 24.6 \text{ nsec}$$

From View point of e^+ stacking

(a) $f_{\text{rep}} = 163 \text{ MHz}$

$$T_{b_ERL} = T_{b_DR} = 6.15 \text{ nsec}$$

Hard: we have to do stacking in every DR turn

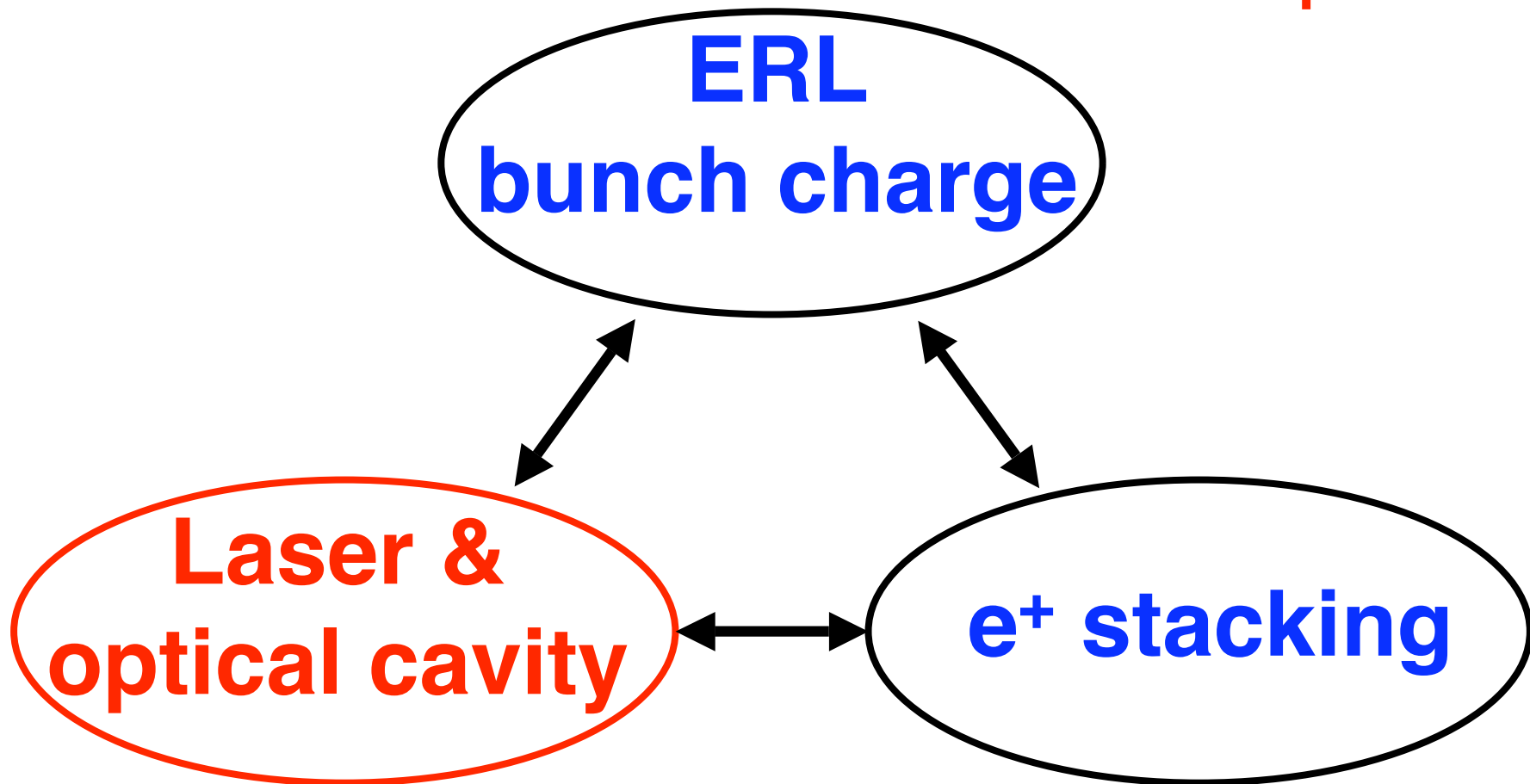
(b) $f_{\text{rep}} = 40.8 \text{ MHz}$

$$T_{b_ERL} = 4T_{b_DR} = 24.6 \text{ nsec}$$

Easier: there are 4 DR turns of damping (bunch position moving in a phase space) before the next stacking.

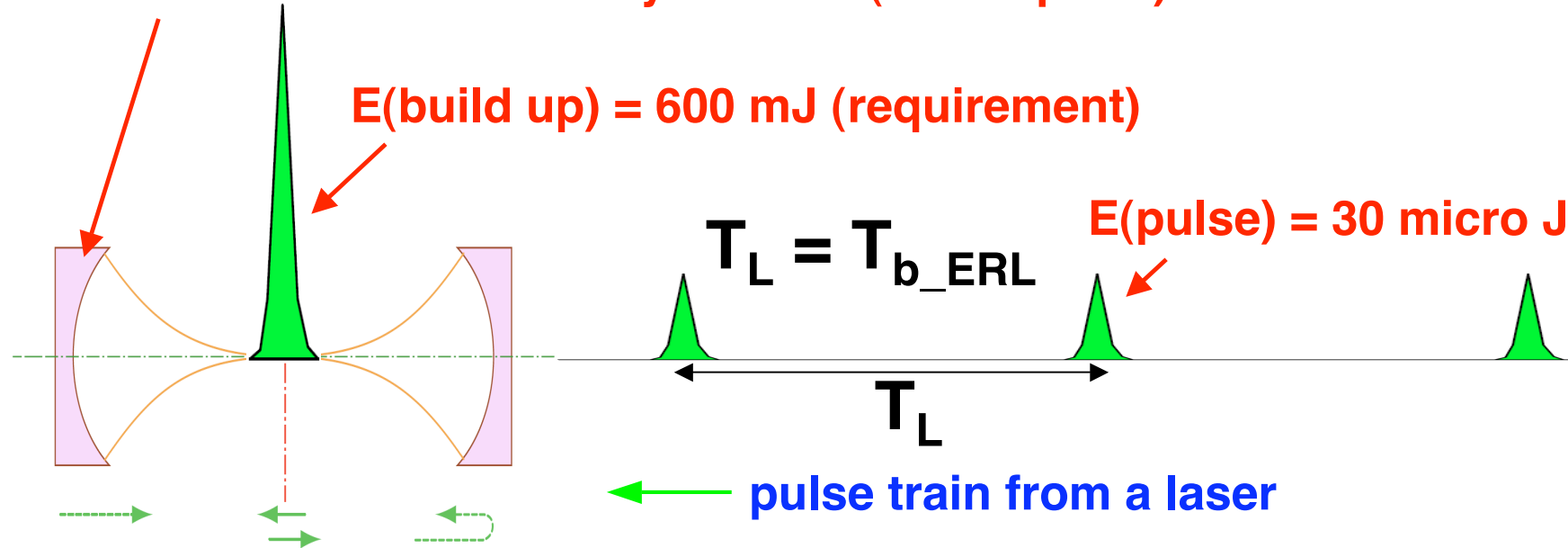
Selection of bunch repetition: f_{rep}

3 factors to determine f_{rep}



Requirement to a laser

Enhancement of the cavity = 20000 (assumption)



(a) $f_{\text{rep}} = 163 \text{ MHz}$ ($T_{b_ERL} = T_L = 6.15 \text{ ns}$)

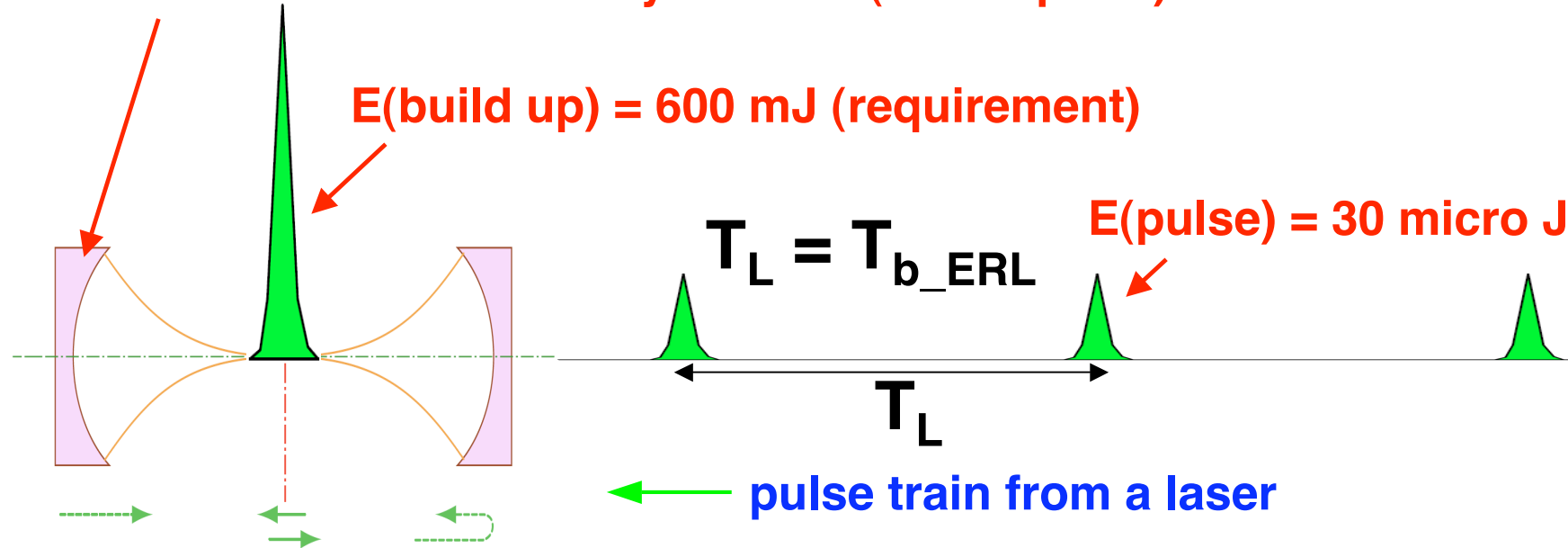
Laser beam power (average) = 4.8 kW

(b) $f_{\text{rep}} = 40.8 \text{ MHz}$ ($T_{b_ERL} = T_L = 24.6 \text{ ns}$)

Laser beam power (average) = 1.2 kW

Requirement to a laser

Enhancement of the cavity = 20000 (assumption)



(a) $f_{\text{rep}} = 163 \text{ MHz}$ ($T_{b_ERL} = T_L = 6.15 \text{ ns}$)

Laser beam power (average) = 4.8 kW

Difficult, but seems in extension of current technology

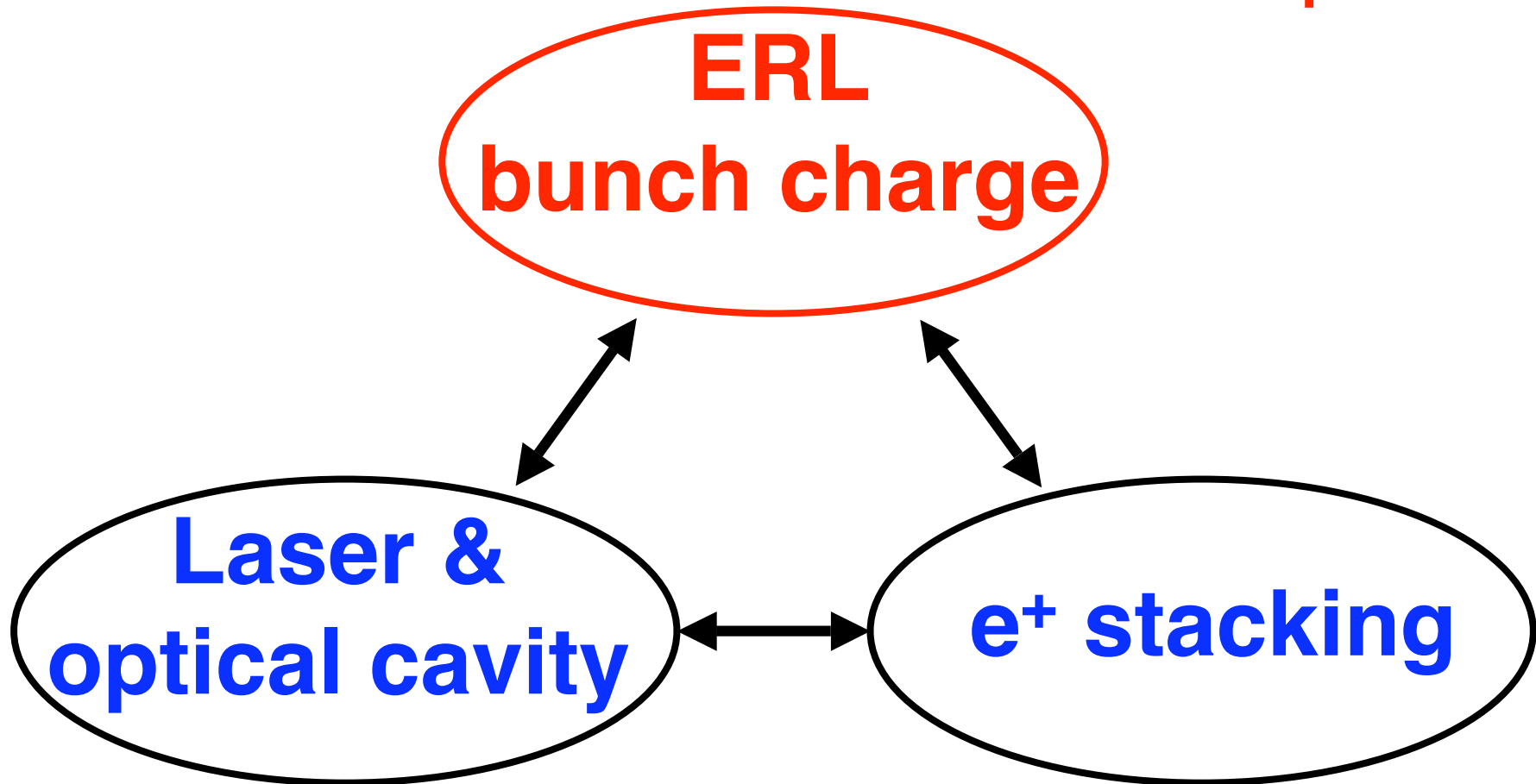
(b) $f_{\text{rep}} = 40.8 \text{ MHz}$ ($T_{b_ERL} = T_L = 24.6 \text{ ns}$)

Laser beam power (average) = 1.2 kW

Easier, But, Difference exists only in average power.

Selection of bunch repetition: f_{rep}

3 factors to determine f_{rep}

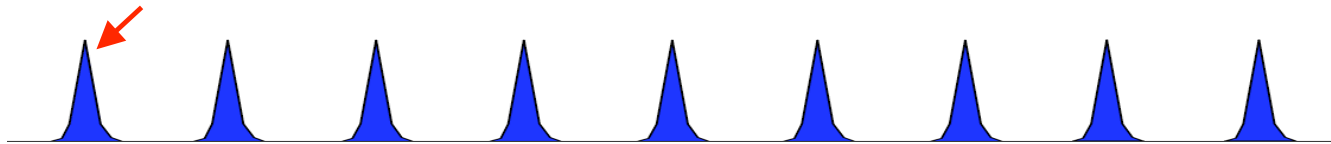


Requirement to an ERL

I (average) = 26 mA (assumption)

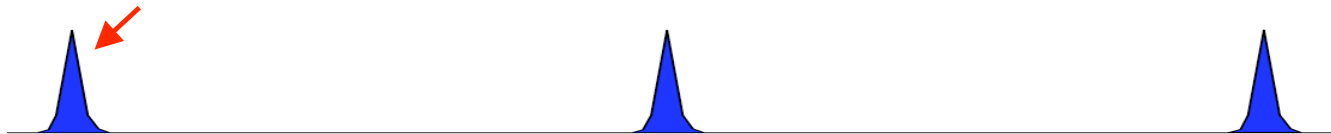
(a) $f_{\text{rep}} = 163 \text{ MHz}$ ($T_{\text{b_ERL}} = 6.15 \text{ ns}$)

$N_e = 1 \times 10^9$ (160pC) /bunch



(b) $f_{\text{rep}} = 40.8 \text{ MHz}$ ($T_{\text{b_ERL}} = 24.6 \text{ ns}$)

$N_e = 4 \times 10^9$ (640pC) /bunch

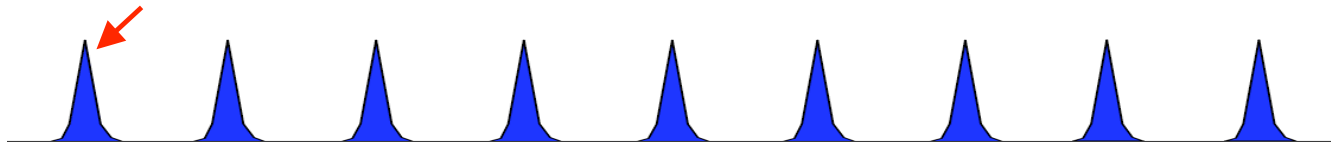


Requirement to an ERL

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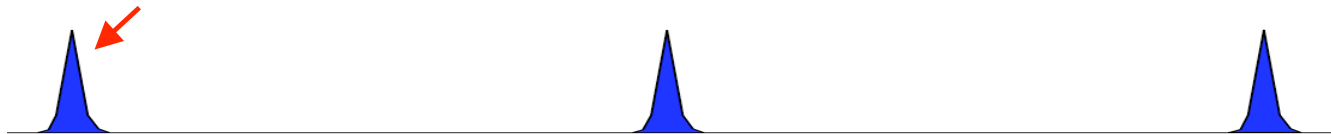
$N_e = 1 \times 10^9$ (160pC) /bunch



Easier, No significant difficulty.

(b) $f_{\text{rep}} = 40.8 \text{ MHz}$ ($T_{\text{b_ERL}} = 24.6 \text{ ns}$)

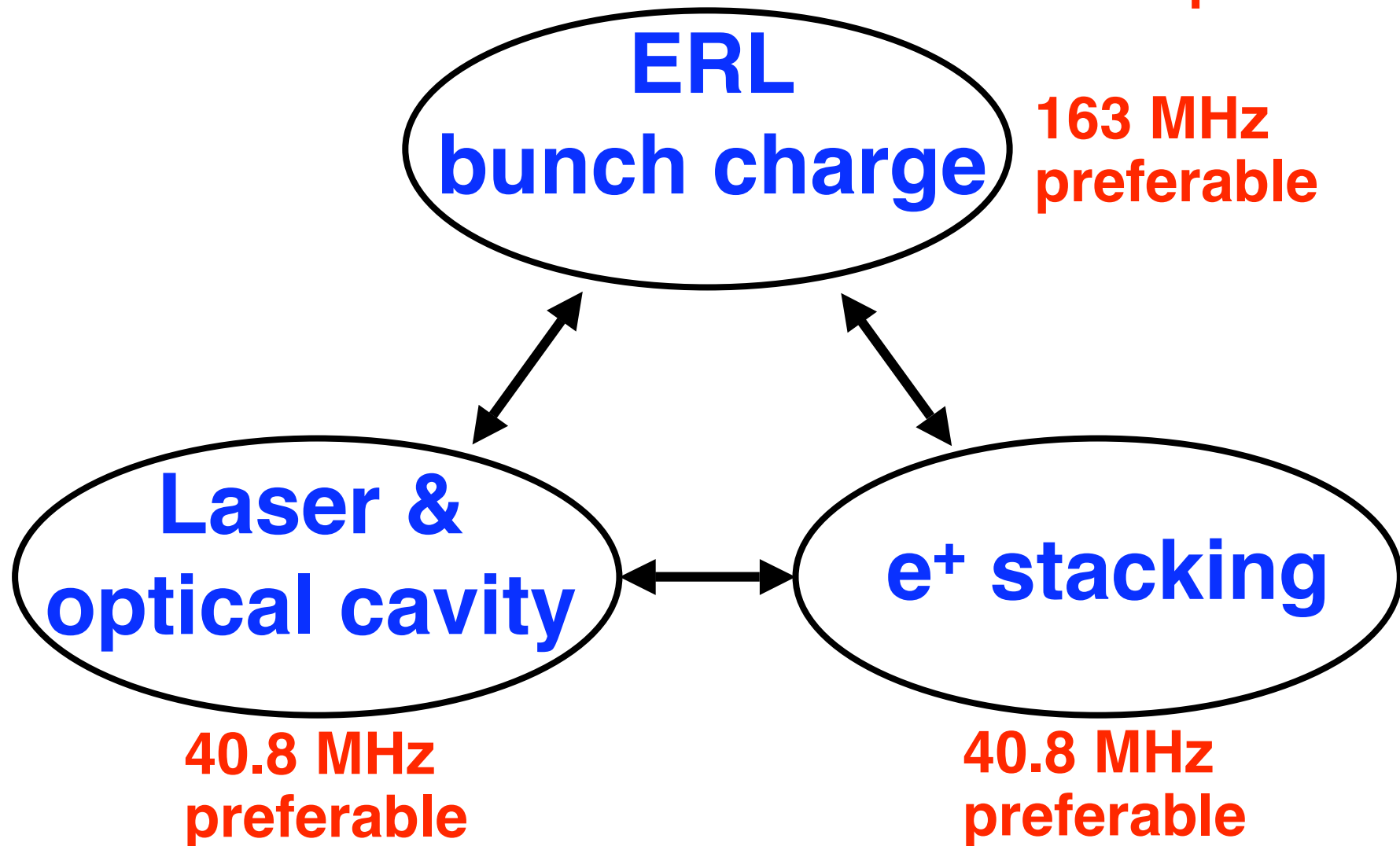
$N_e = 4 \times 10^9$ (640pC) /bunch



**More difficult, wake-field, charge limit at GUN, CSR,,,
But it seems manageable .**

Selection of bunch repetition: f_{rep}

3 factors to determine f_{rep}



N_γ and Ne^+ in single turn of ERL

Laser beam at CP

$$E_{\text{pulse}} = 600 \text{ mJ / cavity}$$

$$\sigma_x = \sigma_y = 5 \text{ micron}$$

$$\sigma_z = 0.7 \text{ psec}$$

Electron beam at CP

$$\sigma_x = \sigma_y = 5 \text{ micron}$$

$$\sigma_z = 0.8 \text{ psec}$$

$$(a) N_e = 1 \times 10^9 \text{ (160pC) (163 MHz)} \rightarrow N_\gamma = 1.6 \times 10^8 \text{ /cavity}$$

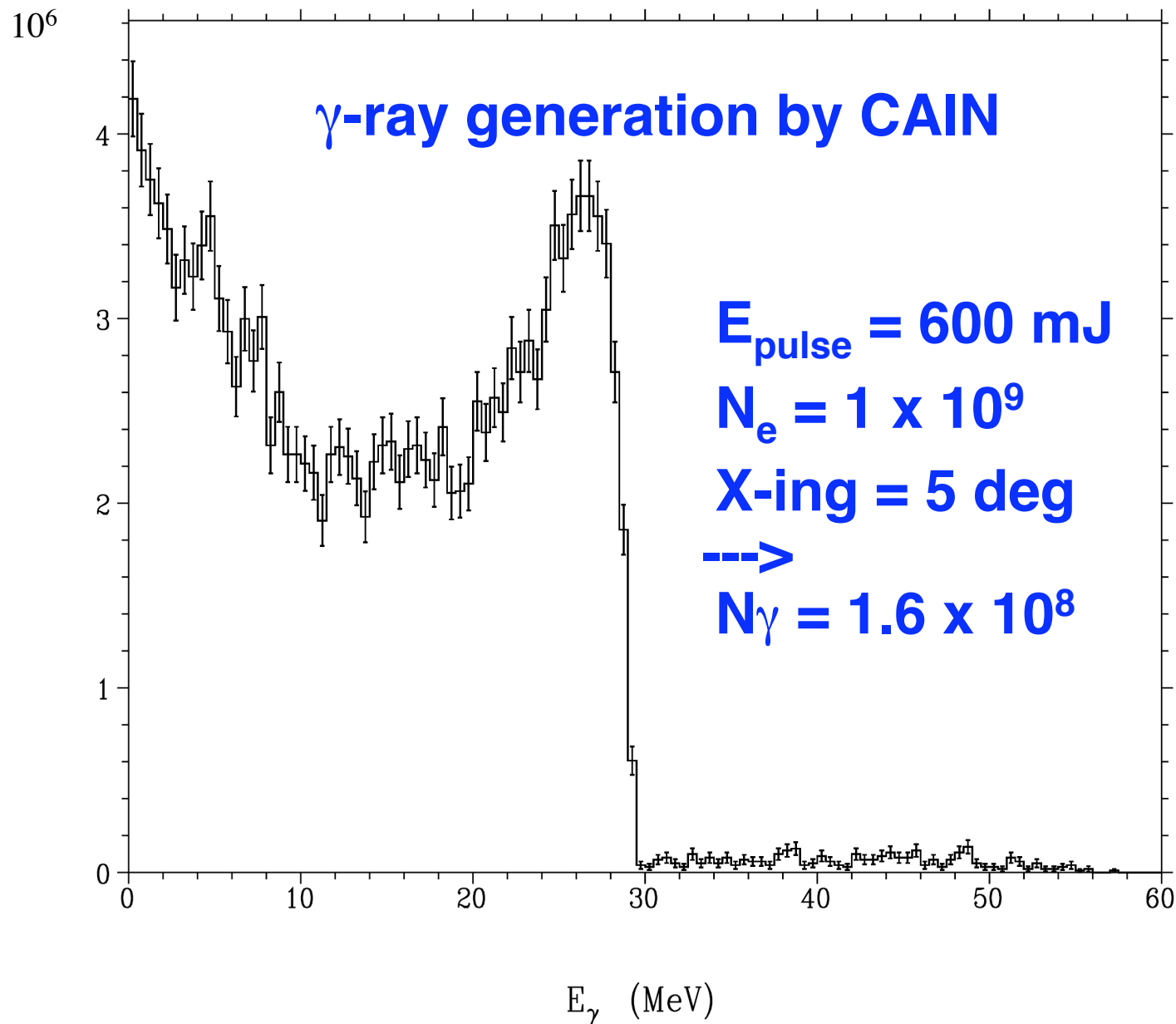
$$(b) N_e = 4 \times 10^9 \text{ (640pC) (40.8 MHz)} \rightarrow N_\gamma = 6.4 \times 10^8 \text{ /cavity}$$

N_γ total (10 optical cavities, $600 \text{ mJ} \times 10 = 6\text{J}$)

$$(a) N_\gamma = 1.6 \times 10^9 \text{ in total} \rightarrow \text{Ne+ (captured)} = 5 \times 10^6$$

$$(b) N_\gamma = 6.4 \times 10^9 \text{ in total} \rightarrow \text{Ne+ (captured)} = 20 \times 10^6$$

Compton Gamma Energy Spectrum



Number of stacking in 100 ms

(a) 163MHz: $N_{e^+}(\text{captured}) = 5 \times 10^6$ /ERL turn

$N_{e^+}(\text{ILC requirement}) = 2 \times 10^{10}$

--> $N_{\text{stacking}} = 4000$ required

One turn of DR = 25 micro sec

stacking in every DR turn --> 4000 DR turns

--> 100 msec

(b) 40.8 MHz: $N_{e^+}(\text{captured}) = 20 \times 10^6$ / ERL turn

$N_{e^+}(\text{ILC requirement}) = 2 \times 10^{10}$

--> $N_{\text{stacking}} = 1000$ required

One turn of DR = 25 micro sec

stacking in every 4 DR turns --> 4000 DR turns

--> 100 msec

Achieve $N_{e^+} = 2 \times 10^{10}$ in both (a) and (b)

Summary

1. ERL -> easy beam compression at CPs
2. ERL -> quasi CW operation:
top-up injection, possibility Pol.~80%
3. Two models:
 $f_{\text{rep}} = \text{(a) } 163\text{MHz and (b) } 40.8\text{MHz}$

Summary

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 $f_{\text{rep}} = \text{(a) } 163\text{MHz and (b) } 40.8\text{MHz}$
4. Both of two are working assumptions.

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 $f_{\text{rep}} = \text{(a) 163MHz and (b) 40.8MHz}$
4. Both of two are working assumptions.
5. Need stacking simulation

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4. Both of two are working assumptions.
5. Need stacking simulation, **Need ERL study**

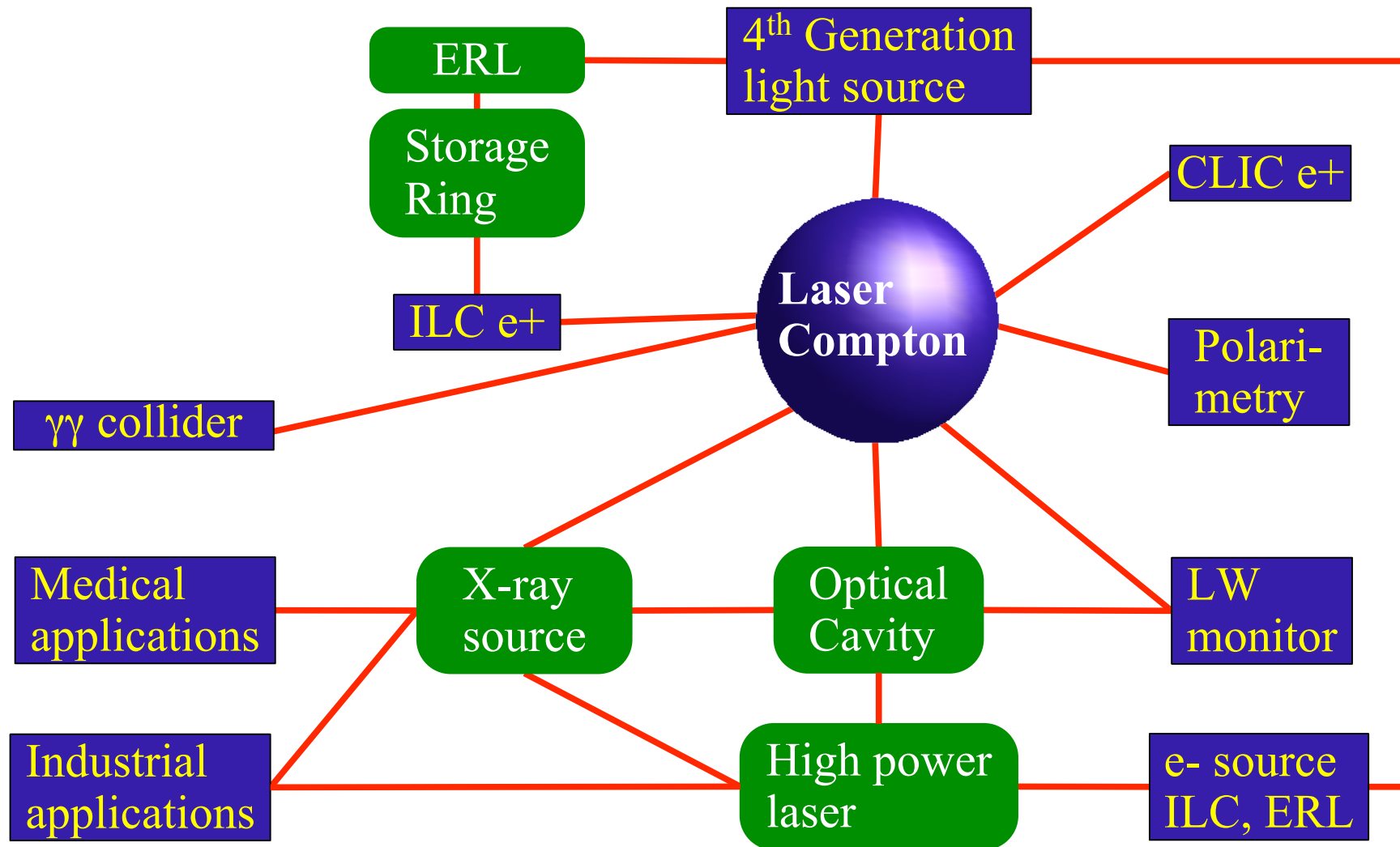
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Need Laser study

Summary

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3. Two models:
 $f_{\text{rep}} = \text{(a) } 163\text{MHz and (b) } 40.8\text{MHz}$
4. Both of two are working assumptions.
5. Need stacking simulation, Need ERL study,
Need Laser study, **Need capture study**

World-Wide-Web of Laser Compton



Kuriki at Beijing e+ meeting 2007

Summary

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2. ERL -> quasi CW operation:
top-up injection, possibility Pol.~80%
3. Two models:
 $f_{\text{rep}} = \text{(a) } 163\text{MHz and (b) } 40.8\text{MHz}$
4. Both of two are working assumptions.
5. Need stacking simulation, Need ERL study,
Need Laser study, Need capture study
6. We have a world-wide collab of Compton.
Not only for ILC e^+ source.
Also for many other applications.

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The END

Thank you for your attention

3 of Compton schemes

similar : re-use

1. Ring-based Compton.

different

2. ERL-based Compton.

new comer: no parameter set yet

3. linac-based Compton.

throw-away